

Low-Frequency Noise Measurements and Applications

Jean-Guy Tartarin

▶ To cite this version:

Jean-Guy Tartarin. Low-Frequency Noise Measurements and Applications: Low-Frequency Noise Metrology For The Development of High-Frequency Technologies and For High Purity Signal Generation. 102th ARFTG Microwave Measurement Symposium, Andrej Rumiantsev, Jan 2024, San Antonio (TX), United States. hal-04440695

HAL Id: hal-04440695 https://hal.science/hal-04440695

Submitted on 6 Feb 2024

HAL is a multi-disciplinary open access archive for the deposit and dissemination of scientific research documents, whether they are published or not. The documents may come from teaching and research institutions in France or abroad, or from public or private research centers. L'archive ouverte pluridisciplinaire **HAL**, est destinée au dépôt et à la diffusion de documents scientifiques de niveau recherche, publiés ou non, émanant des établissements d'enseignement et de recherche français ou étrangers, des laboratoires publics ou privés.



January 21-24, 2024

102nd ARFTG Microwave Measurement Symposium

Microwave Measurement Conference

Low-Frequency Noise Metrology For The Development of High-Frequency Technologies and For High Purity Signal Generation



Pr. J.G. TARTARIN

LAAS-CNRS & University of Toulouse (Université Paul Sabatier), France

Manager of the European Platform for "Low Frequency and RTN Noise" labeled by Keysight Leader of the « HF analog Devices for telecommunications» of Reliability platform PROOF



Platform of Reliability tOOIs for Failure analysis dedicated to wide bandgap devices



Université de Toulouse





- ELECTRONIC NOISE: in France and at LAAS-CNRS
- LOW FREQUENCY NOISE (LFN) : metrological niche ? Not only !

- LFN EXPERIMENTAL SETUPS: a large variety of solutions from home-made to commercial solutions
- APPLICATIONS OF LFN MEASUREMENTS : defect detection, reliability analysis, nonlinear RF circuit design (VCOs, Mixers).
- CONCLUSIONS and QUESTIONS









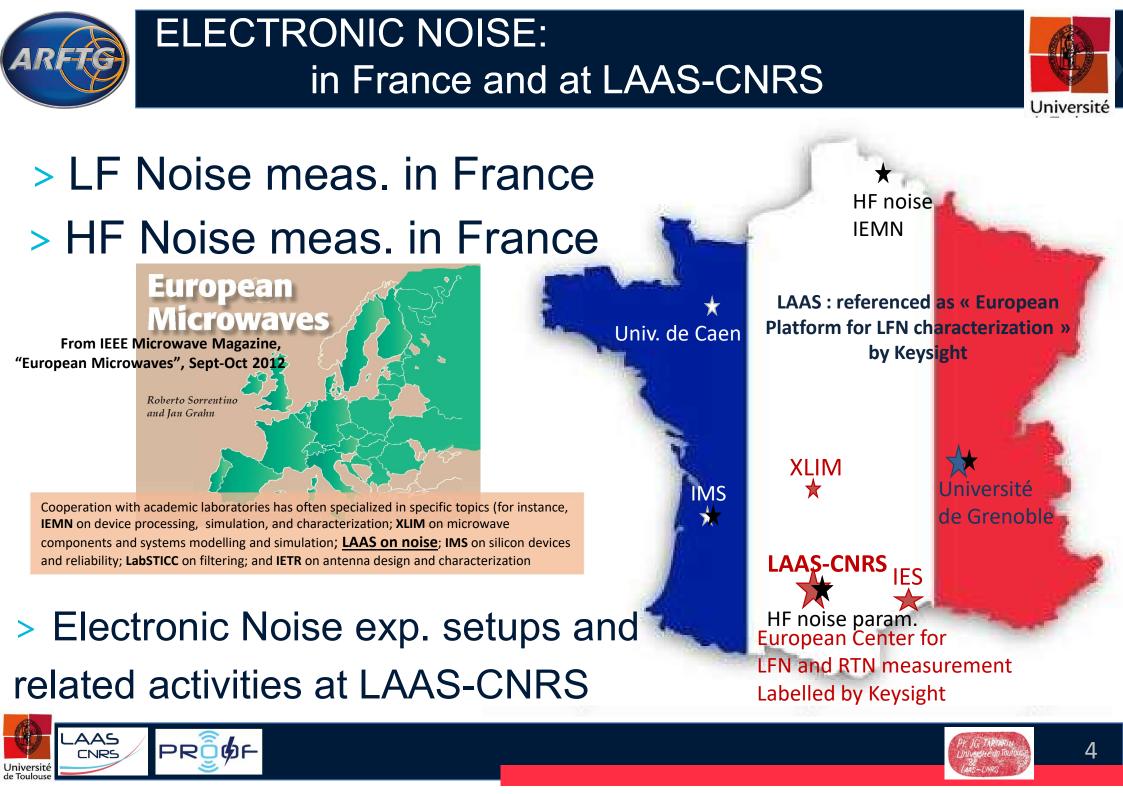
- ELECTRONIC NOISE: in France and at LAAS-CNRS
- LOW FREQUENCY NOISE (LFN) : metrological niche ? Not only !

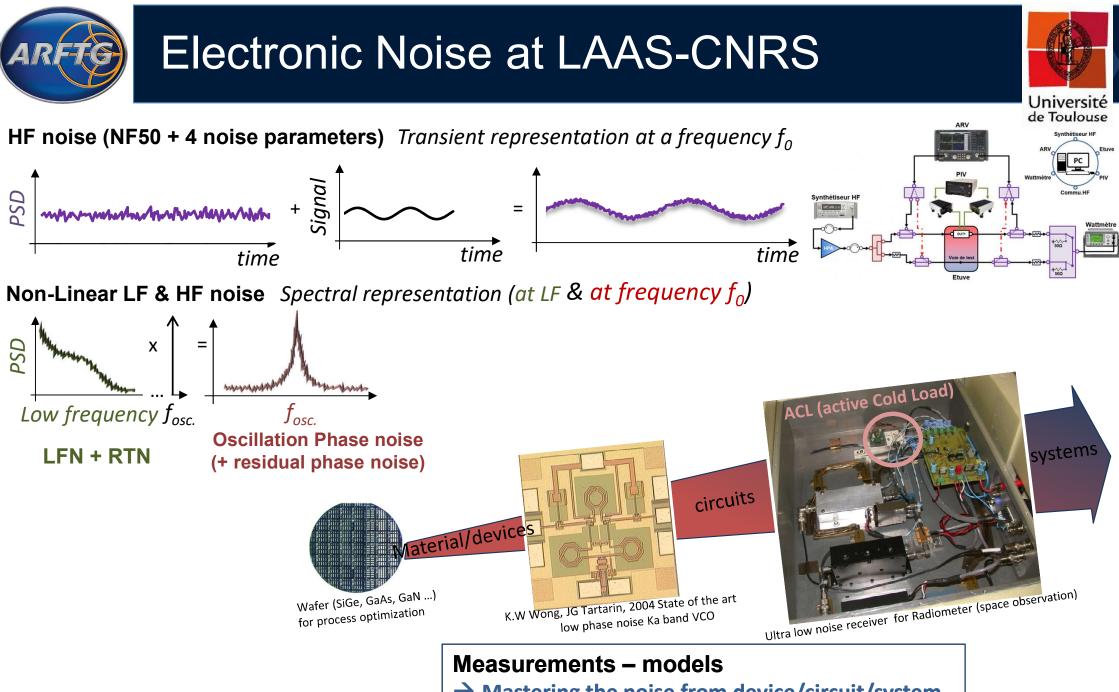
- LFN EXPERIMENTAL SETUPS: a large variety of solutions from home-made to commercial solutions
- APPLICATIONS OF LFN MEASUREMENTS : defect detection, reliability analysis, nonlinear RF circuit design (VCOs, Mixers).
- CONCLUSIONS and QUESTIONS











AAS

PROGF

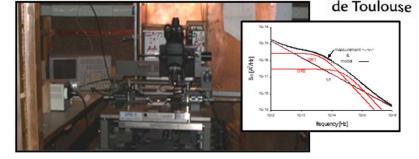
 \rightarrow Mastering the noise from device/circuit/system





ELECTRONIC NOISE: Noise measurement facilities at LAAS-CNRS

LFN and RTN: the LAAS CNRS has been developing low frequency noise (LFN) metrology means for more than six decades, which allow it to claim very low levels of detectivity performance $(10^{-28} \text{ A/Hz}^{1/2})$ and up to 1 MHz.



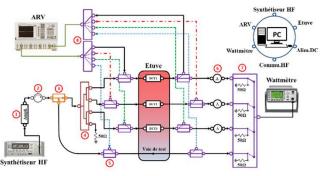
Labeled as a European Platform for LFN and RTN by Keysight since 2017

HF NF50 and 4 noise parameters: different (evolving and automated) worbenches for noise measurement from 10 MHz to 50 GHz. NFA and PNA-X option 029 from Keysight HF NF50 NL noise under pumping signal: evolution of NF50 under

aggressive EM signal (jamming, interferences)

Integration of LFN & HF noise measurements in situ - reliability testbench : The 4-channel RF and thermal test bench allows Full-DC characterization, [S] parameter characterization, NL P_{out}-P_{in} AND LFN (output) spectra, and NF50 measurement without removing connectors.













Electronic Noise at LAAS-CNRS

Main scientific fields :

New devices :

Modelling and noise sources identification - process improvement

Reliability :

Reliability through noise measurement, at device and circuit level – process improvement

Linear & Nonlinear circuits and noise :

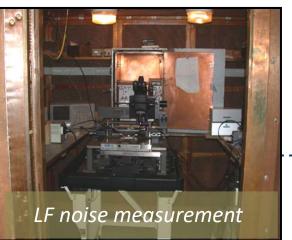
- Noise sources modelling under nonlinear conditions
- Low Noise Amplifier design harshness vs jamming (+ nonlinear noise figure)
- Phase noise modelling (oscillator, amplifier...)

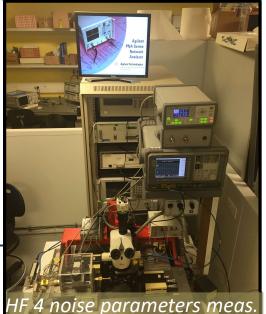
Noise in complex systems :

- Noise in frequency synthesis,
- Noise in Tx/Rx RF links...

Noise metrology :

- Low frequency noise (1/f GR RTN)
- Microwave linear noise (NF50, 4 parameters)
- Nonlinear HF noise
- Phase noise (RF and microwave sources)
- additive phase noise
- Optical noise (ex : laser RIN, ∆v)





Pr. JG TARTARIN



0.01-50 GHz





Université de Toulouse





Main scientific fields :

New devices :

Modelling and noise sources identification - process improvement

Reliability :

Reliability through noise

NOISE IN ELECTRONIC DEVICES / CIRCUITS / SYSTEMS since 1998

- 5 International or European Programs on LF noise
- Linear & Nonlinear circ 1 PEPR and 10 ANR French National projects Noise sources modelling 22 projects with Loading Industries in Europe
 - Noise sources modelling Low Noise Amplifier desi Clint, Detents and 2 Software Delegans

6 Int. Patents and 3 Software Releases

98 Int. Publications in Journals & Symposiums

Noise in complex systems .

Phase noise modelling

- Noise in frequency synthesis,
- Noise in Tx/Rx RF links...

Noise metrology :

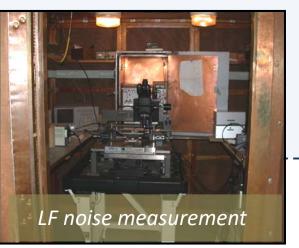
- Low frequency noise (1/f GR RTN)
- Microwave linear noise (NF50, 4 parameters)
- Nonlinear HF noise

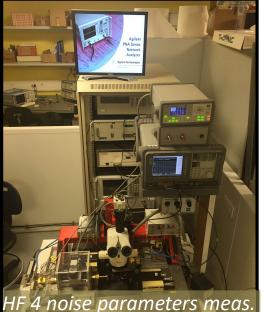
PRODE

Pr. JG TARTARIN

AAS

1 Pr; 1 Research Engineer, 2-3 Ph.D. students / year







0.01-50 GHz

8



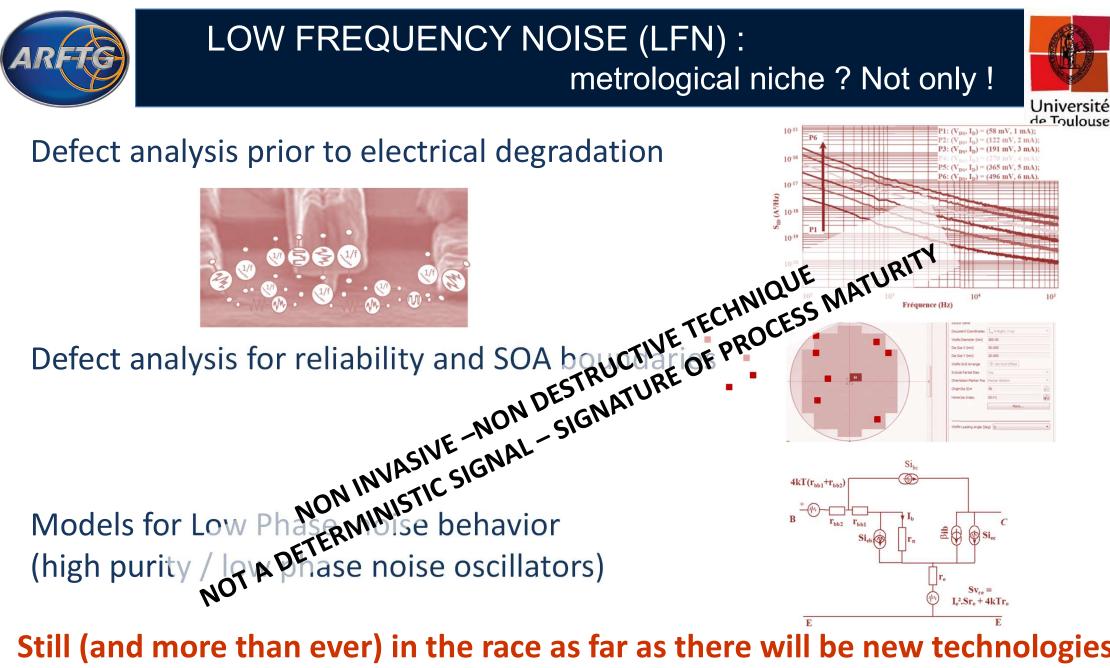


- ELECTRONIC NOISE: in France and at LAAS-CNRS
- LOW FREQUENCY NOISE (LFN) : metrological niche ? Not only !

- LFN EXPERIMENTAL SETUPS: a large variety of solutions from home-made to commercial solutions
- APPLICATIONS OF LFN MEASUREMENTS : defect detection, reliability analysis, nonlinear RF circuit design (VCOs, Mixers).
- CONCLUSIONS and QUESTIONS







Still (and more than ever) in the race as far as there will be new technologies and signal-detection noise floor !







LOW FREQUENCY NOISE (LFN) :

metrological niche ? Not only !



Is LFN old fashioned?

- International Conference on Fluctuation and Noise, since 1968 and still alive (Fluctuation And Noise, and other noise-dedicated conferences are out now)

- International Conference on Fluctuation and Noise 2023, Grenoble, France:
- -invited paper « $\ensuremath{\text{Low frequency noise in qubits}}$ » by Mark Dykman $\ensuremath{\text{Theory}}$
- -quantum system and noise session Theory
- -quantum devices and noise Electronic Devices & Material
- -quantum transport and superconductivity session Theory

Where to find noise (and LFN) in Conferences or Journals:

- IMS: International Microwave Symposium (USA) – every year, sessions dedicated to low noise devices (EuMW), circuits (EuMiC) and systems (EuRAD)

- EuMW: European Microwave Week (Europe) - every year, almost the same format as for IMS

- ESREF: European Symposium on Reliability of Electron Devices – no dedicated session BUT LFN is used for fialure dedection and degradation analysis in (active) devices

- RADECS: RADiations and its Effects on Components and Systems Conference (Europe) and many other

- Journals: IEEE (MTT, EDL, SSE), AIP publishing, Cambridge Univ. Press, Elsevier... ponctual publ.





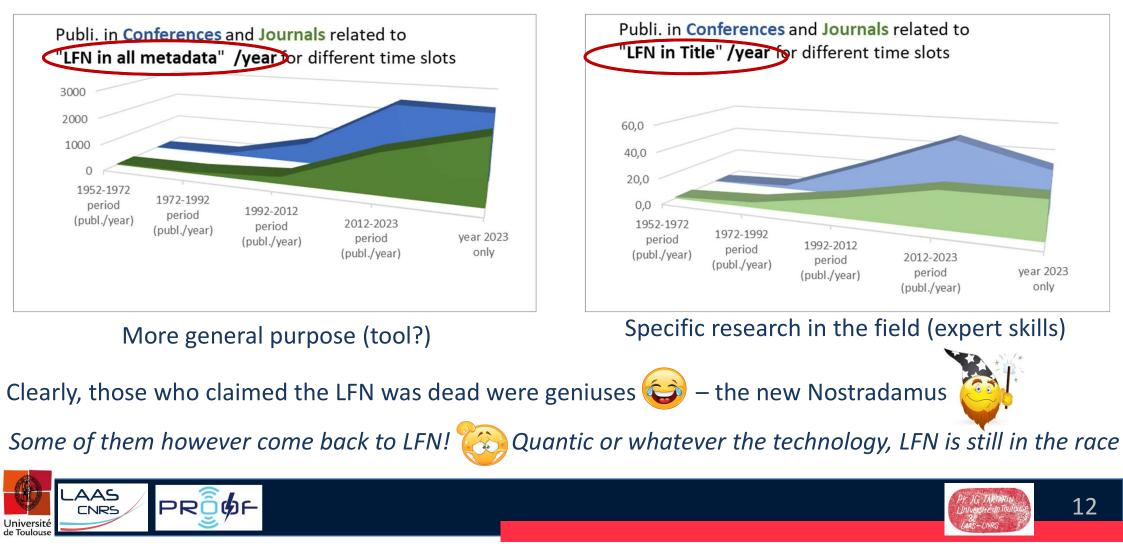




Research on data base from IEEE EXPLORE over different periods: from (1912 to) 1952 to 2023

1912-1952 : 75 journals (i.e. average of 1.8 publications/year)

1952-2023 : large increase in the use of LFN (theory/metrology/applied physics or technological assessment)





LOW FREQUENCY NOISE (LFN) :

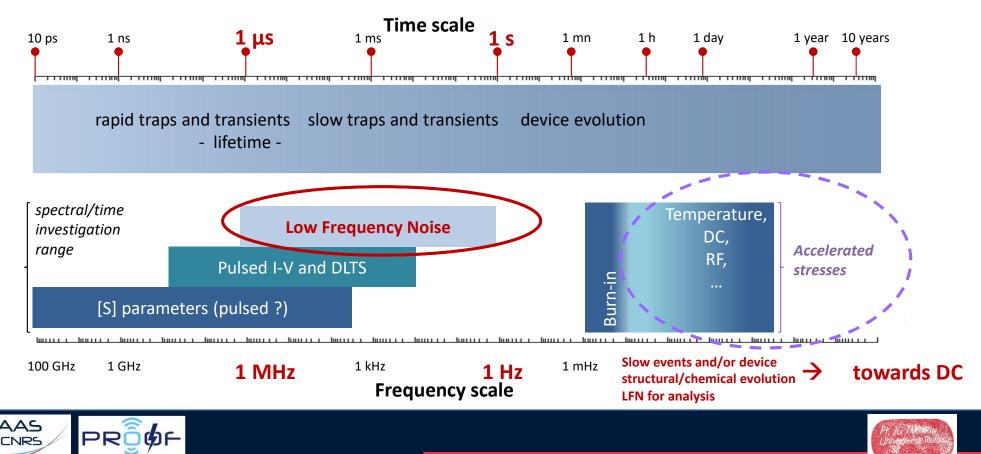
metrological niche ? Not only !



LFN within other frequency characterization.

Discrimination between time constants / impact of the experimental setup ?

- Non invasive measurement techniques for failure analysis (LFN, pulsed electrical, DLTS, ...)
 - \rightarrow Investigation of technological defects at t₀
 - ightarrow Evolution of the device's perf. during stress





- ELECTRONIC NOISE: in France and at LAAS-CNRS
- LOW FREQUENCY NOISE (LFN) : metrological niche ? Not only !
- LFN EXPERIMENTAL SETUPS: a large variety of solutions from home-made to commercial solutions
- APPLICATIONS OF LFN MEASUREMENTS : defect detection, reliability analysis, nonlinear RF circuit design (VCOs, Mixers).
- CONCLUSIONS and QUESTIONS









AAS

Universit



Internal noise in electronic devices:

Linear noise:

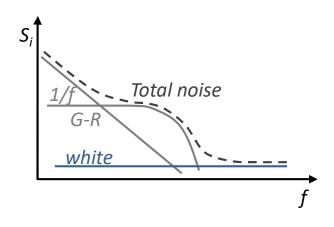
Linear noise: White Noise (thermal noise, shot noise, diff $\int_{0}^{\frac{1}{2}} \int_{0}^{1E-18}$

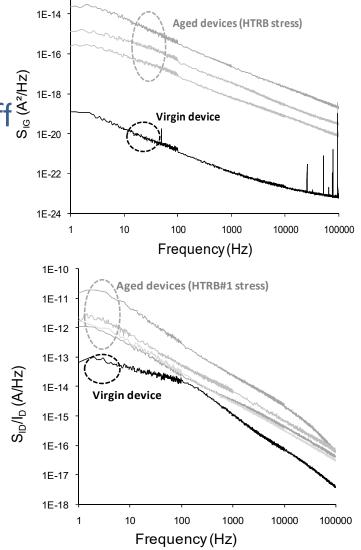
Non-linear -Excess Noise (can be reducted):

> 1/f noise

PRODE

- Generation-recombinaison (G-R)
- Random Telegraph Noise(RTS or RTN)

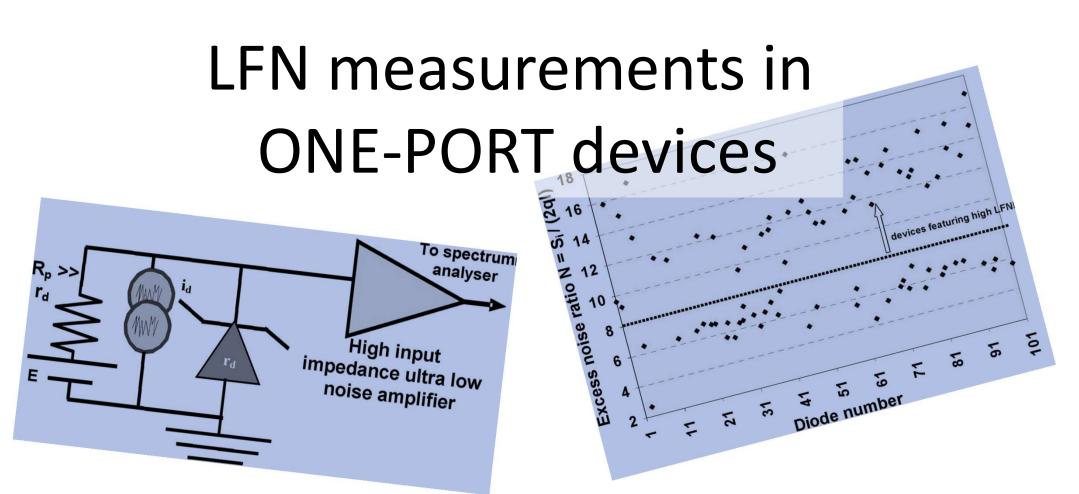






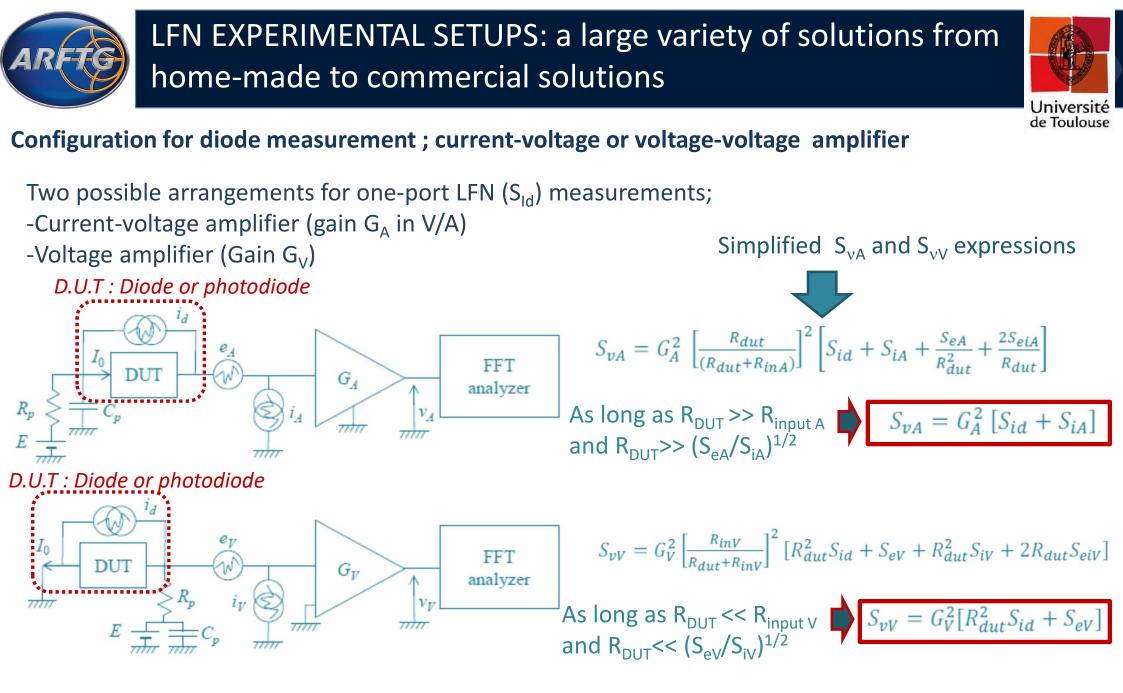














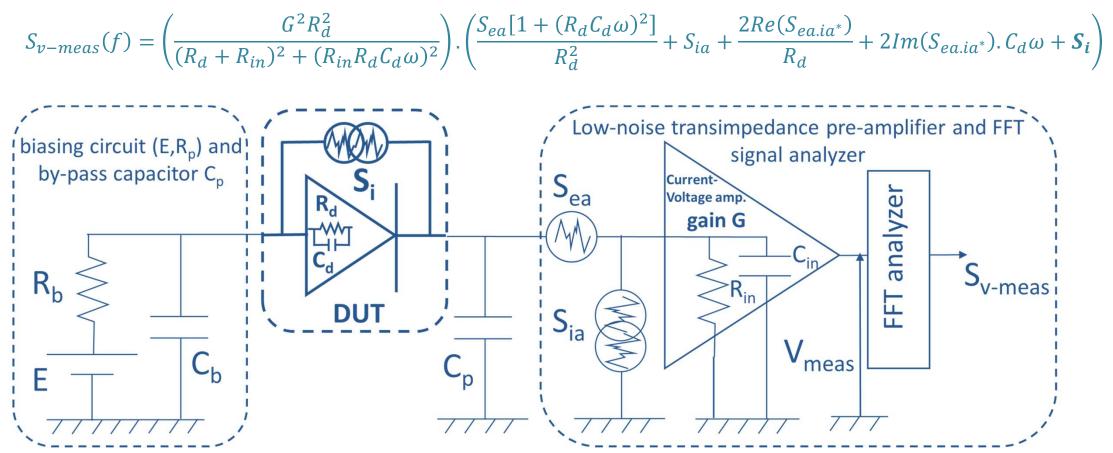






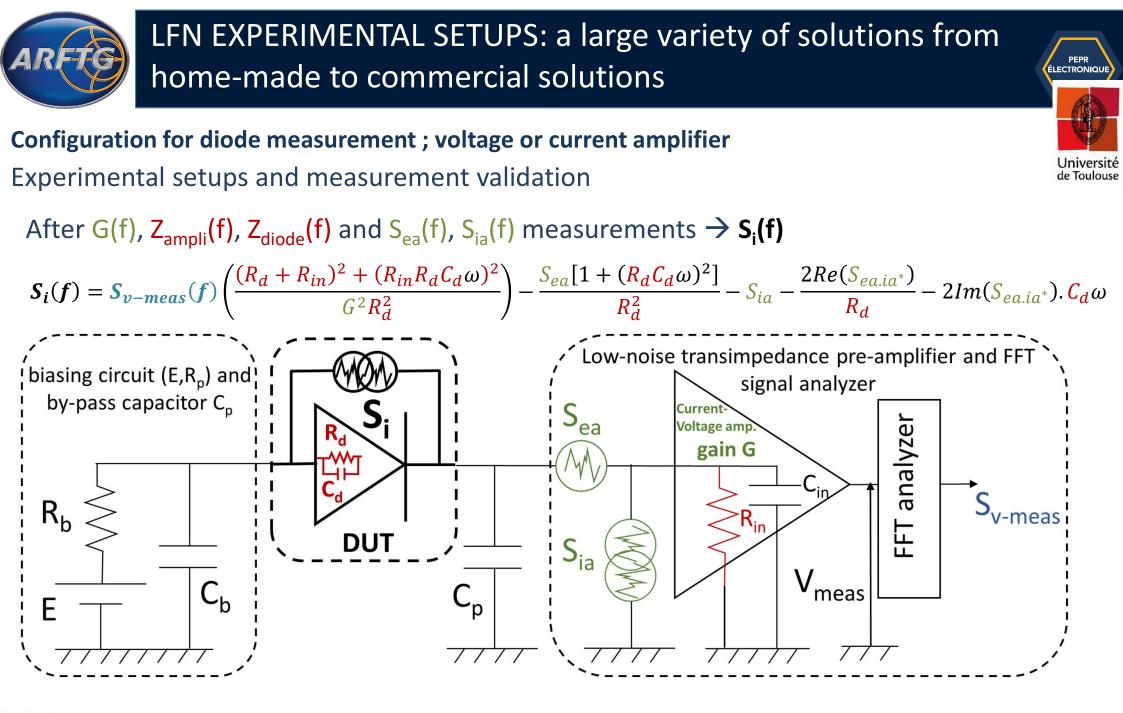
Configuration for diode measurement ; current-voltage amplifier

DUT impedance is elevated \rightarrow transimpedance ampl. ! All the elements are measured prior to LFN meas. Below is the full expression for S_{v-meas}



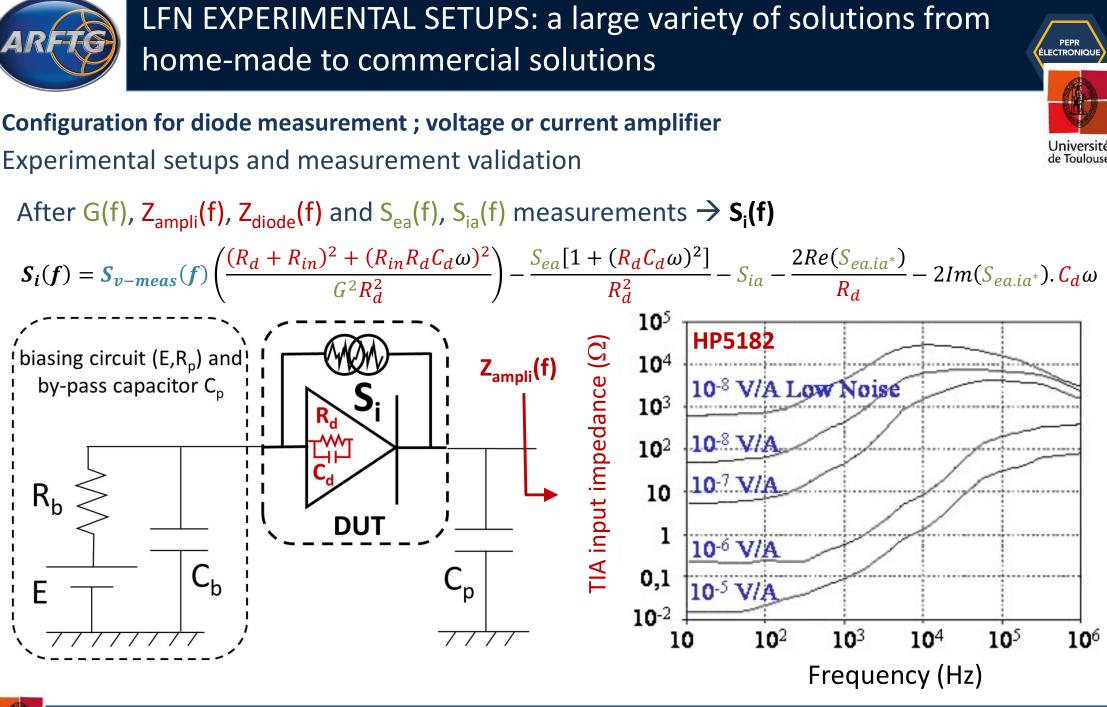








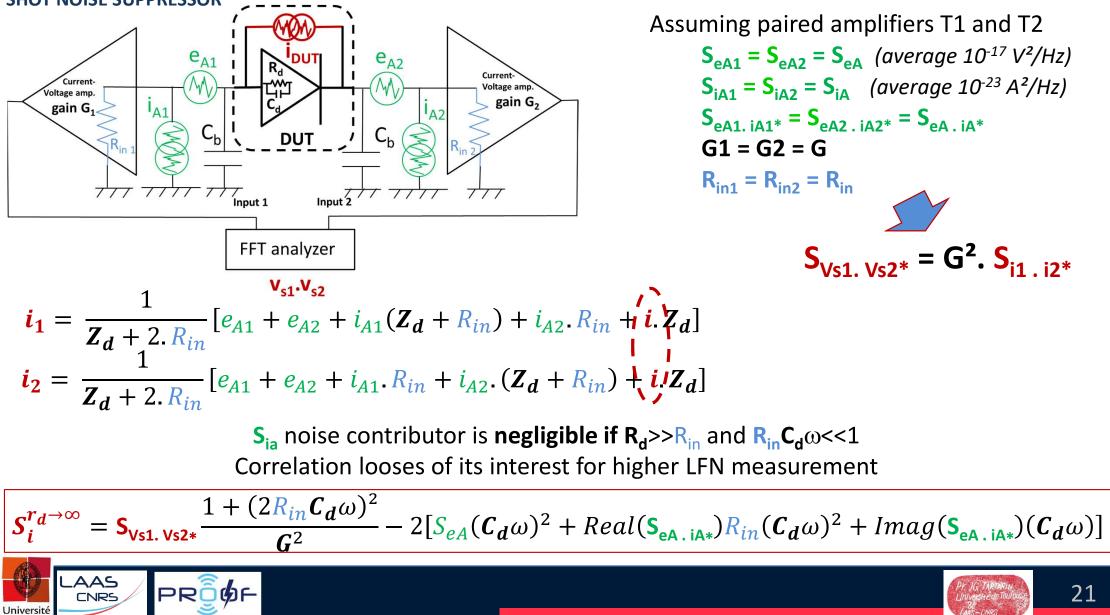








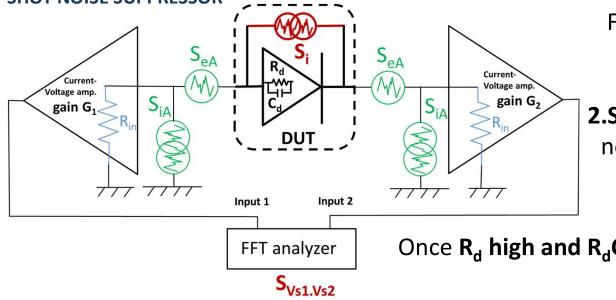
Configuration to improve the noise floor for diode measurement ; by cross-correlation technique Toulouse SHOT NOISE SUPPRESSOR







Configuration to improve the noise floor for diode measurement ; by cross-correlation technique Toulouse SHOT NOISE SUPPRESSOR



From this configuration, S_{eA} (average $10^{-17} V^2/Hz$) associated to each of the 2 amplifiers (even if paired) will produce a **current noise** $2.S_{eA}(1+[r_dC_d\omega]^2)/r_d^2$ (if neglecting C_p and R_{in}). This noise contributor will be amplified by G1 and G2, but will not be eliminated by correlation.

Once **R**_d **high and R**_d**C**_dω<<1, then this current noise is negligible and correlation technique is strongly efficient

<u>Case 1</u>: when **DUT (diode) is forward biased** (even at low level !), R_d should reach 30 k Ω for example (diode biased as low as Id=80 nA) and the parasitic noise becomes 2.10⁻¹⁷/9.10⁸=2.2 10⁻²⁶ A²/Hz \rightarrow same as for a shot noise from a diode under 60 nA !

<u>Case 2</u> : If such diode presents $C_d = 30 \text{ pF}$, at 100 kHz $(1 + [r_d C_d \omega]^2)/r_d^2$ increases up to 10^9 : the parasitic noise now corresponds to a diode biased under 90 nA \rightarrow Higher than the current noise to be measured !!!







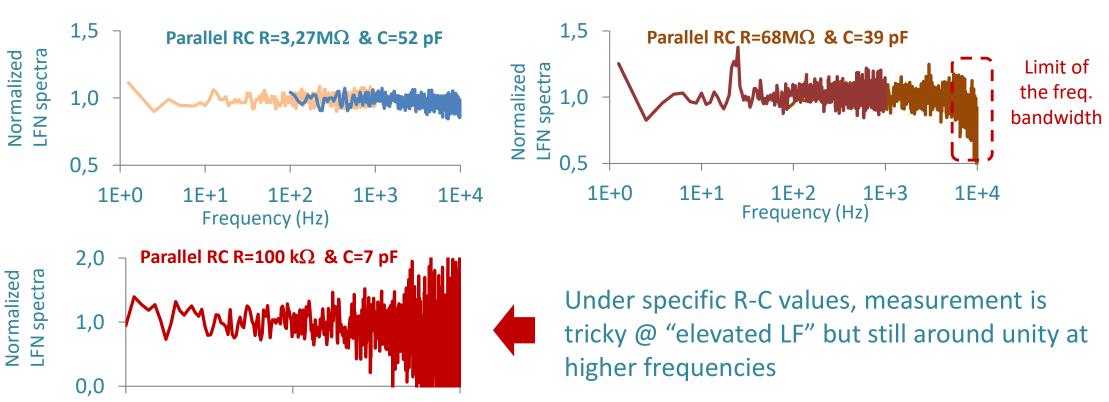
Université de Toulouse

Configuration for diode measurement ; voltage or current amplifier

Experimental setups and measurement validation

1E+5

Frequency (Hz)



1E+6

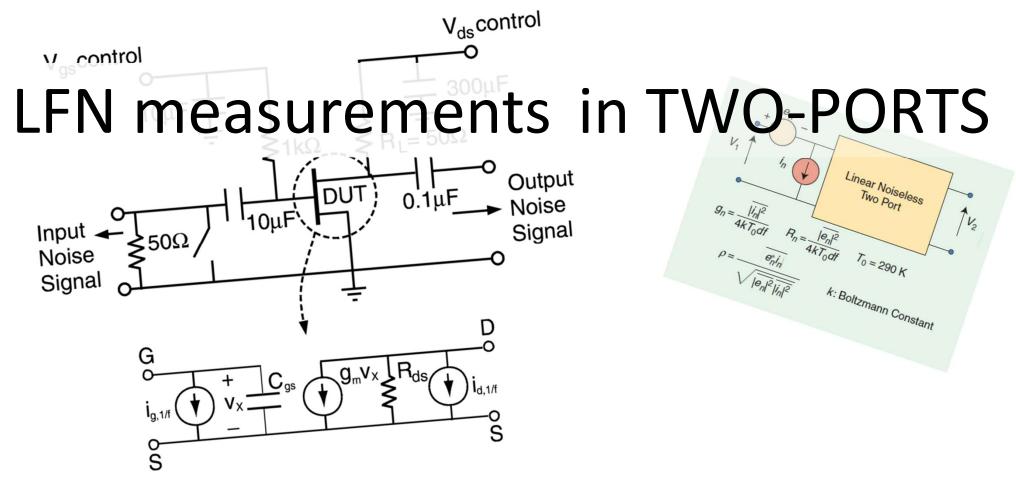
CALIBRATION STEP – resistors and diodes



1E+4









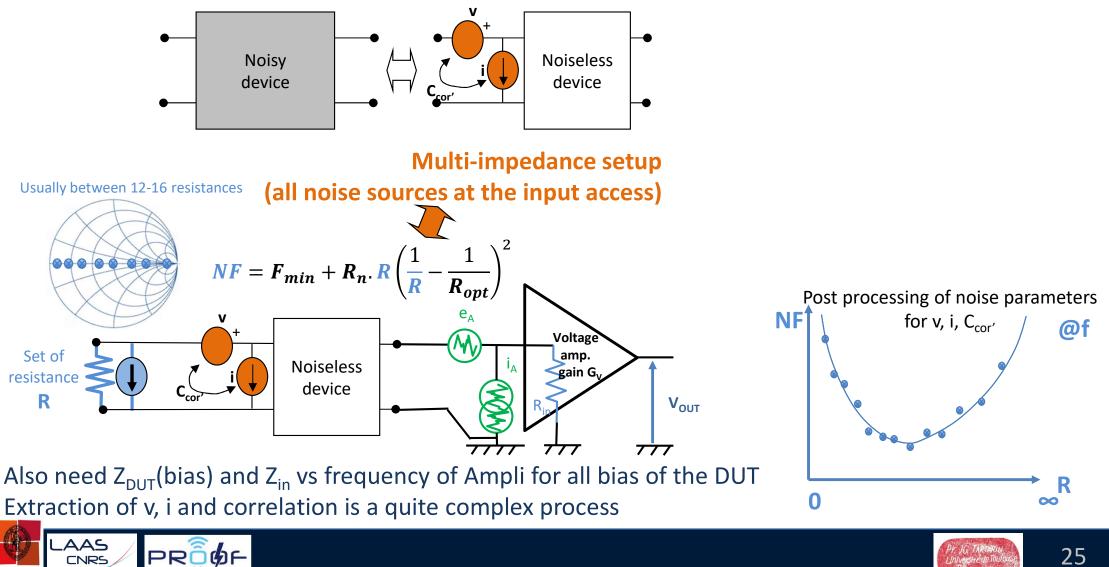


Université de Toulouse



LFN EXPERIMENTAL SETUPS: a large variety of solutions from home-made to commercial solutions

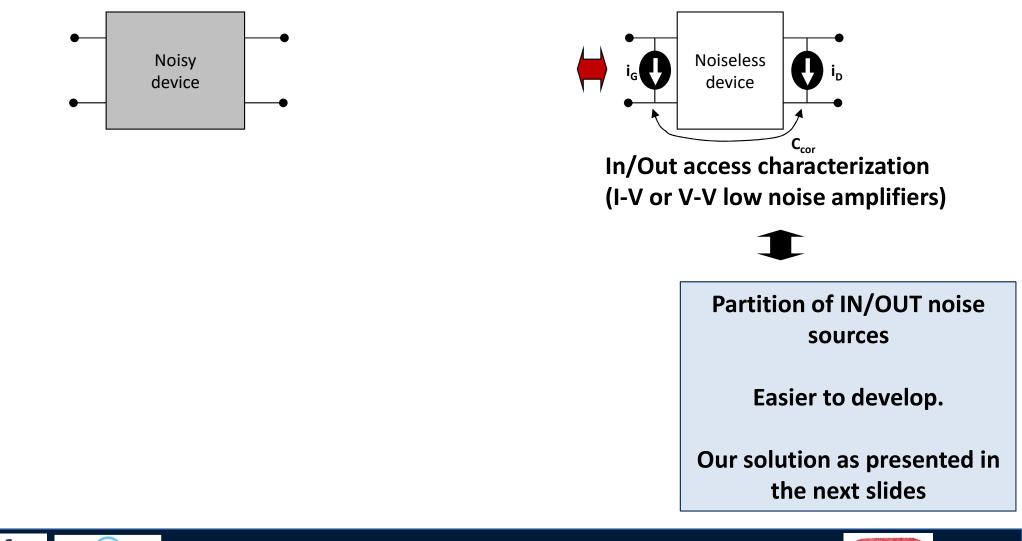
Université de Toulouse









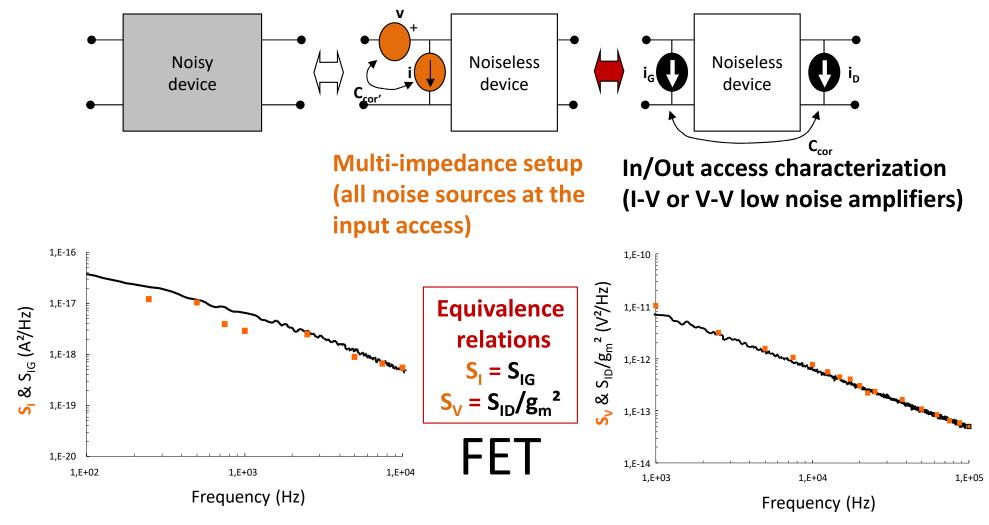










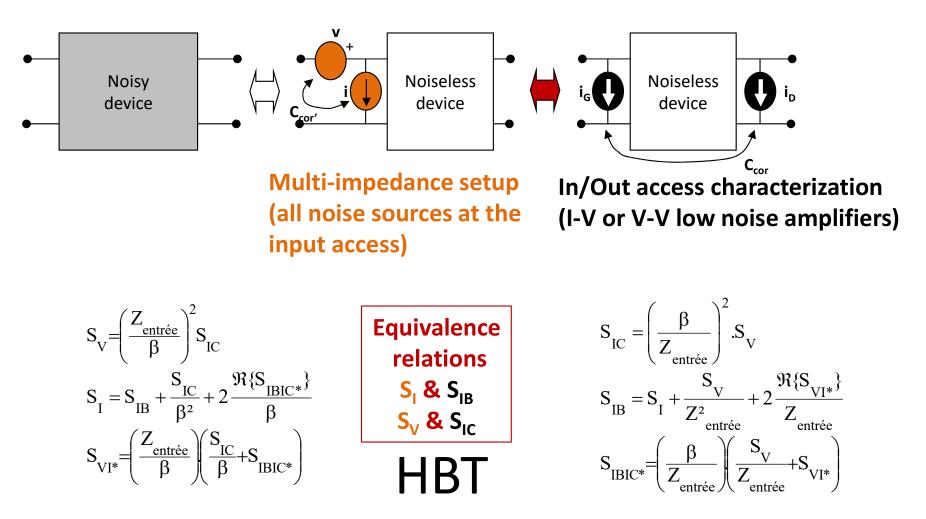














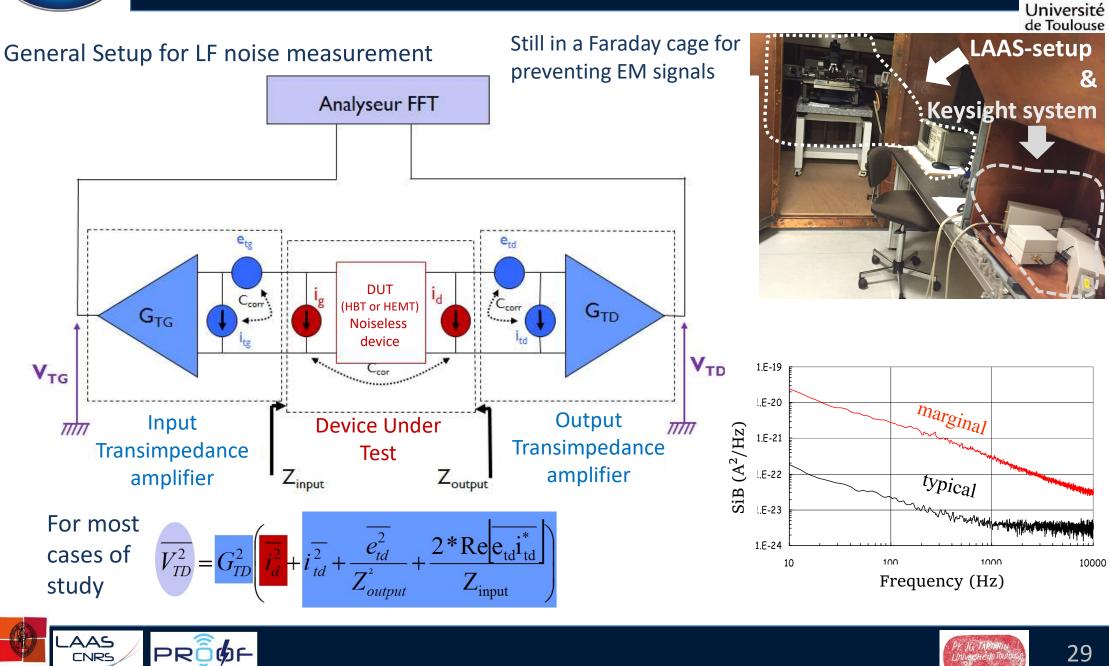




CNRS

Universite

LFN EXPERIMENTAL SETUPS: a large variety of solutions from home-made to commercial solutions







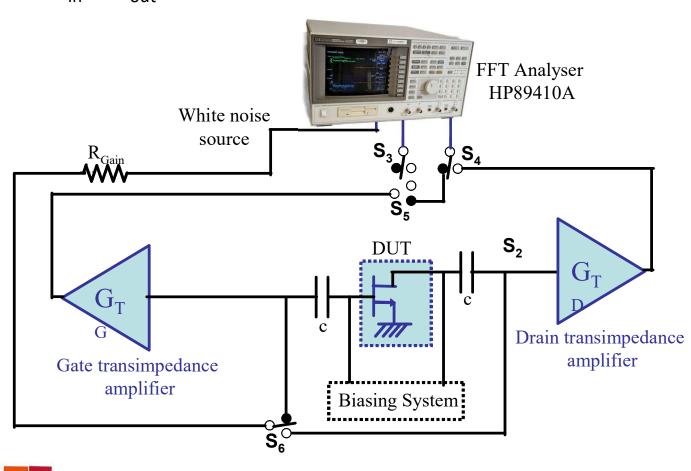
4AS

PRÔØF

LFN EXPERIMENTAL SETUPS: a large variety of solutions from **home-made** to commercial solutions



LOW FREQUENCY NOISE MEASUREMENTS: In/Out + correlation **Non-Linear LF noise (1Hz-1MHz, 2 exp. Tools + Keysight LFNA)** : \rightarrow Si_{in} – Si_{out} & correlation



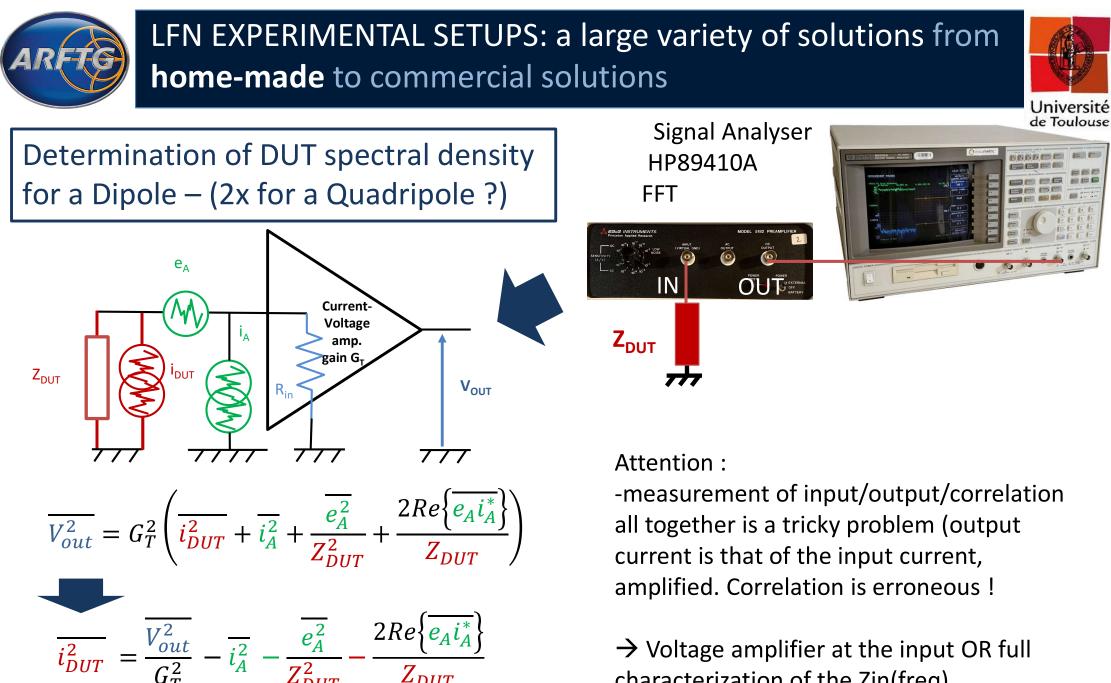


Faraday shielded room (LF noise)

A set of switches is used for the calibration of the different elements (amplifiers) and for :

- SI_{IN}
- SI_{OUT}
- IN-OUT correlation



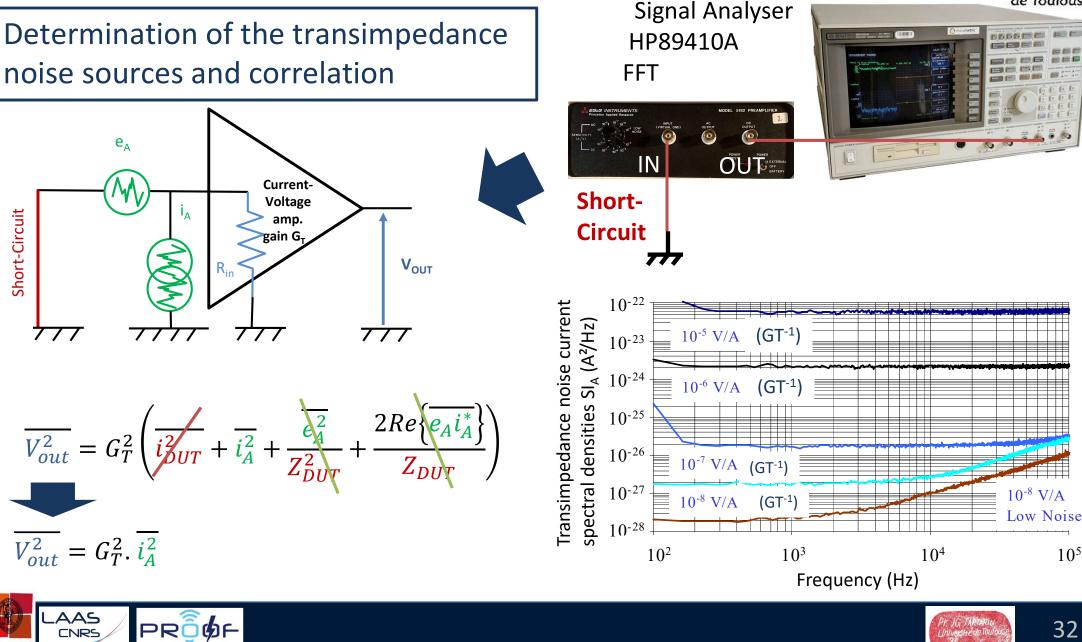


 \rightarrow Voltage amplifier at the input OR full characterization of the Zin(freq)



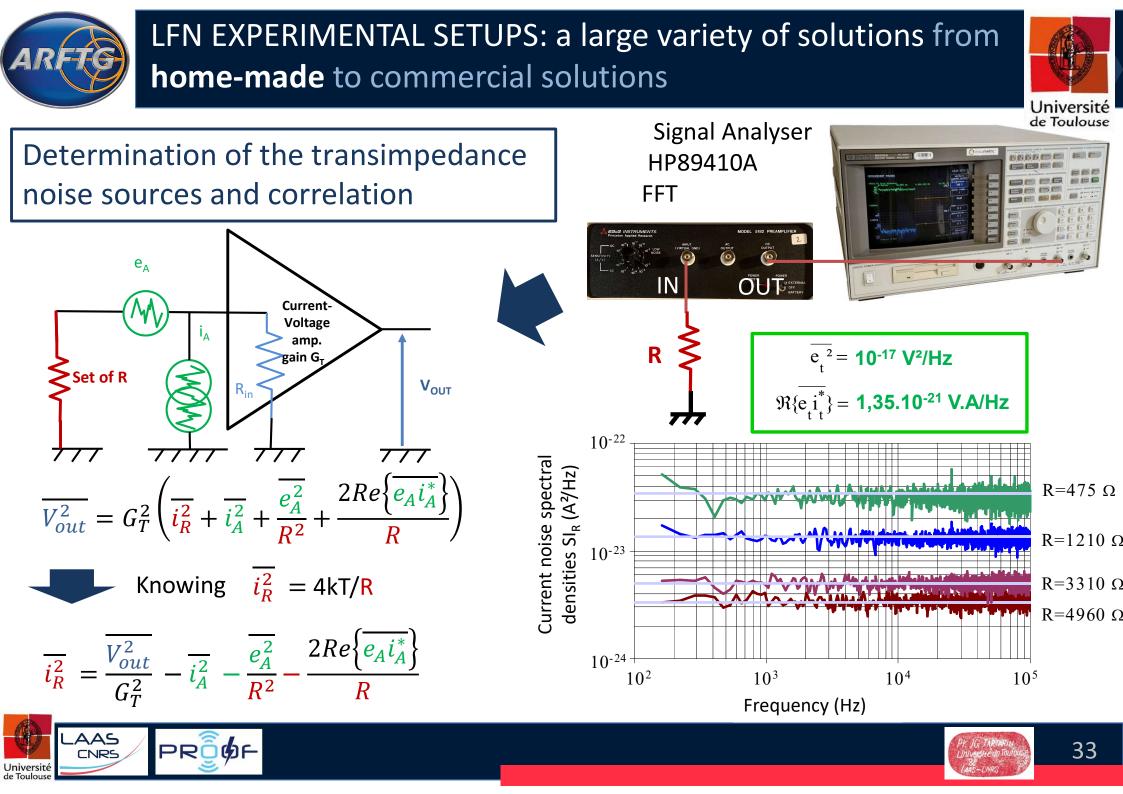






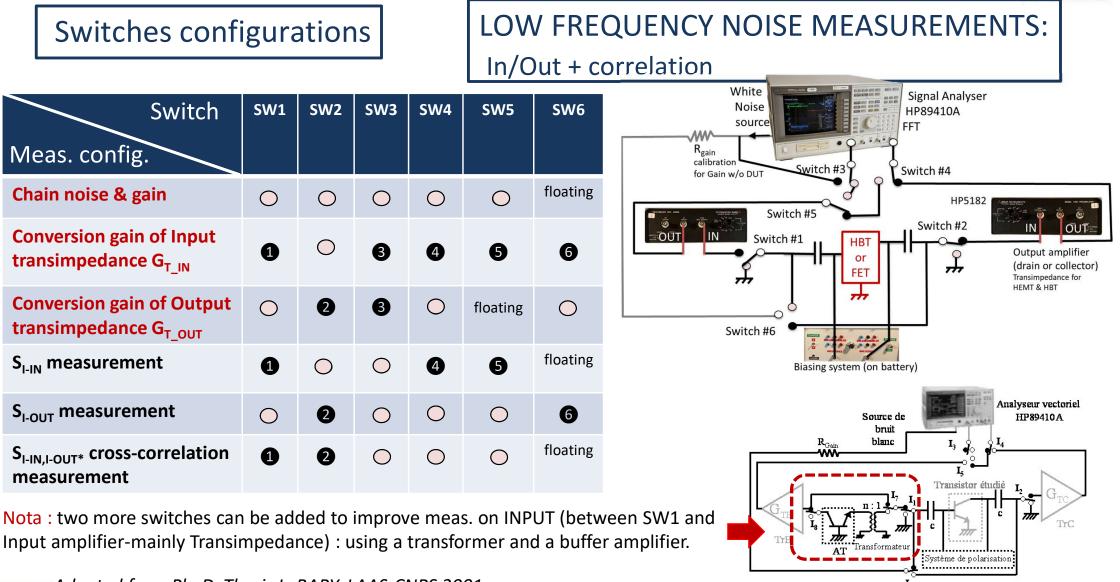
32

 10^{5}



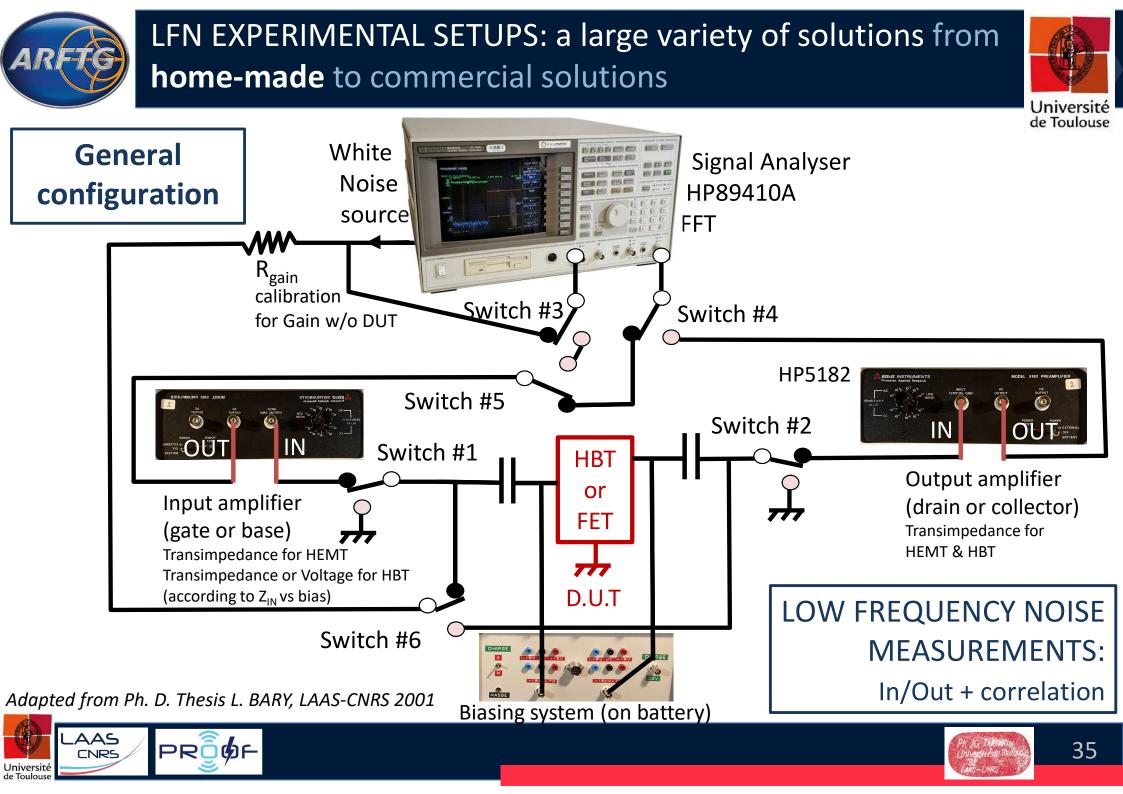


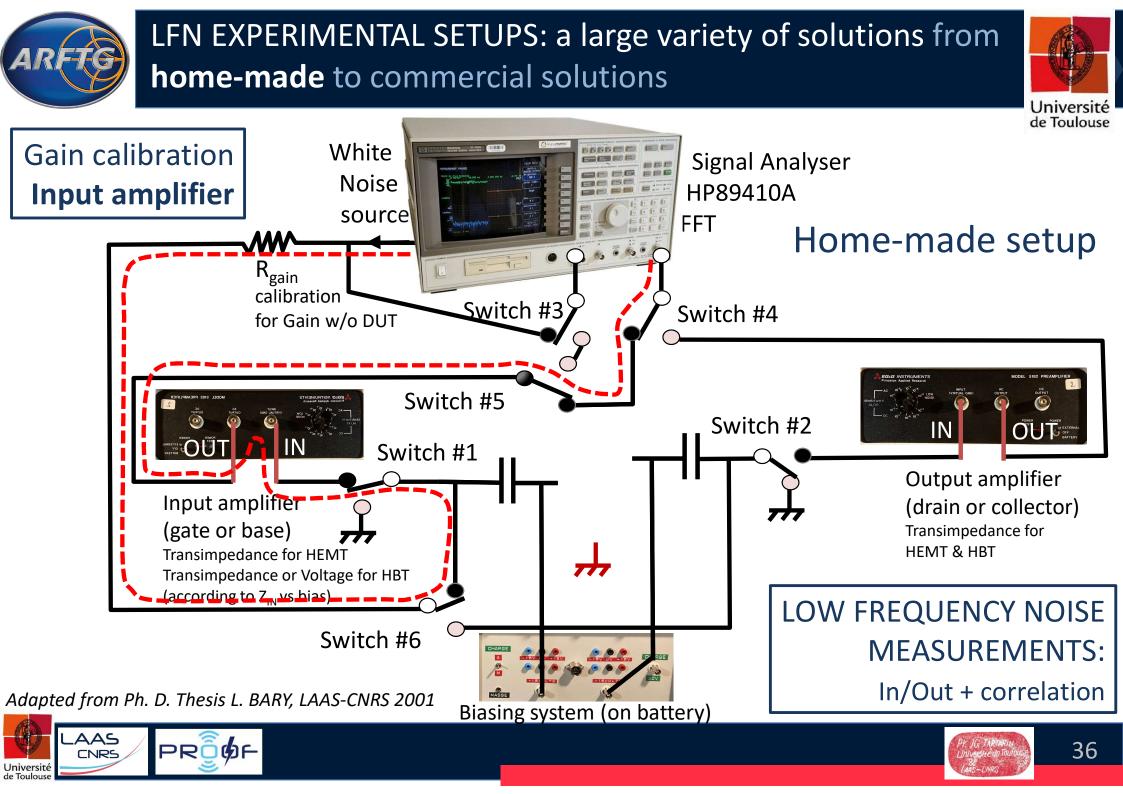


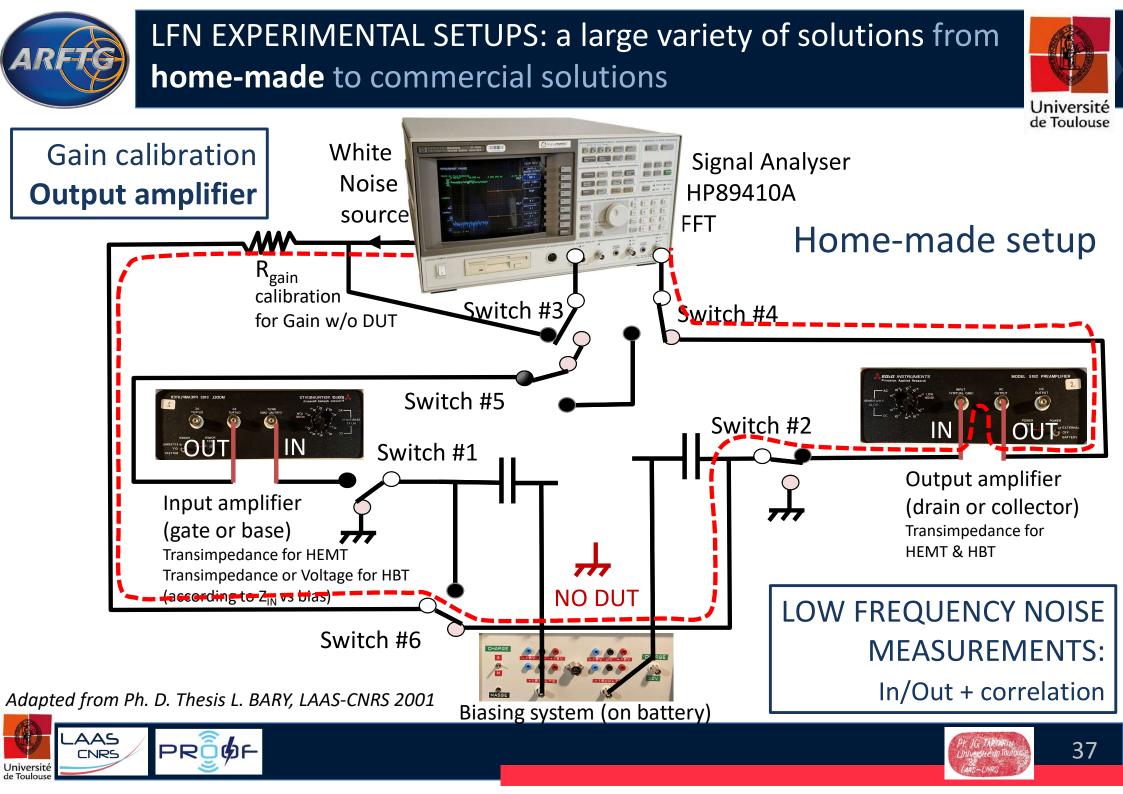


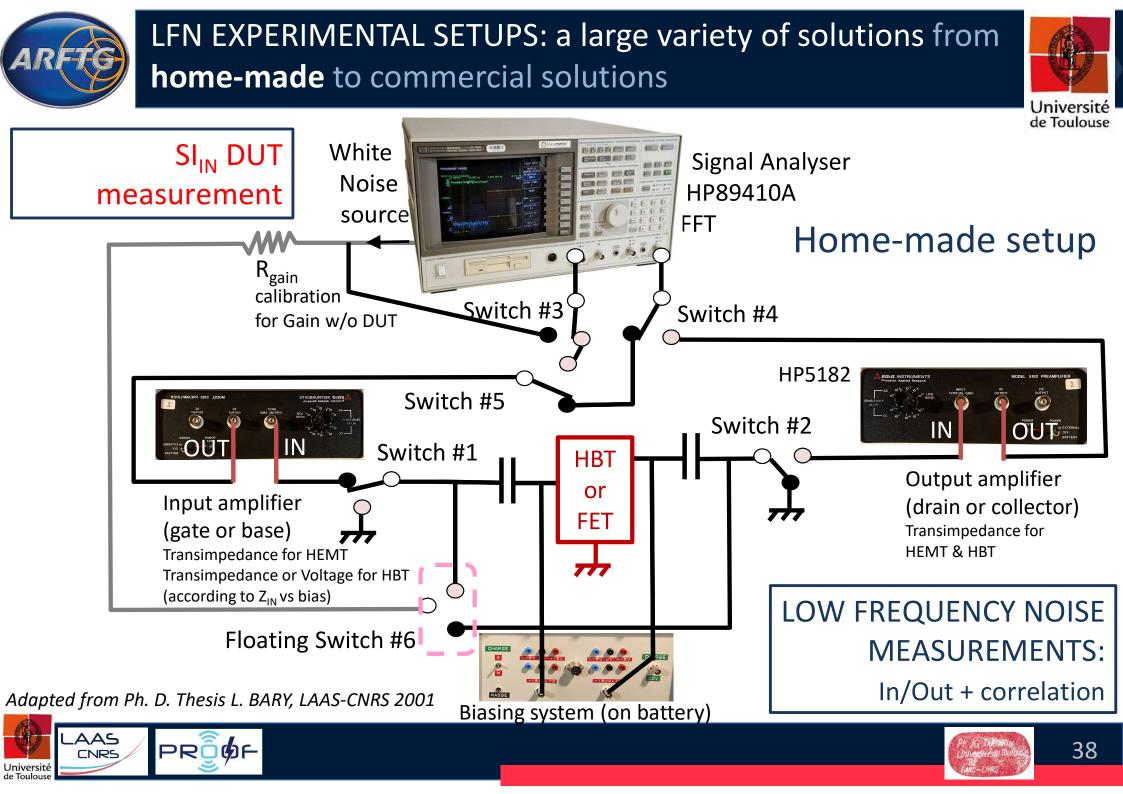
Adapted from Ph. D. Thesis L. BARY, LAAS-CNRS 2001

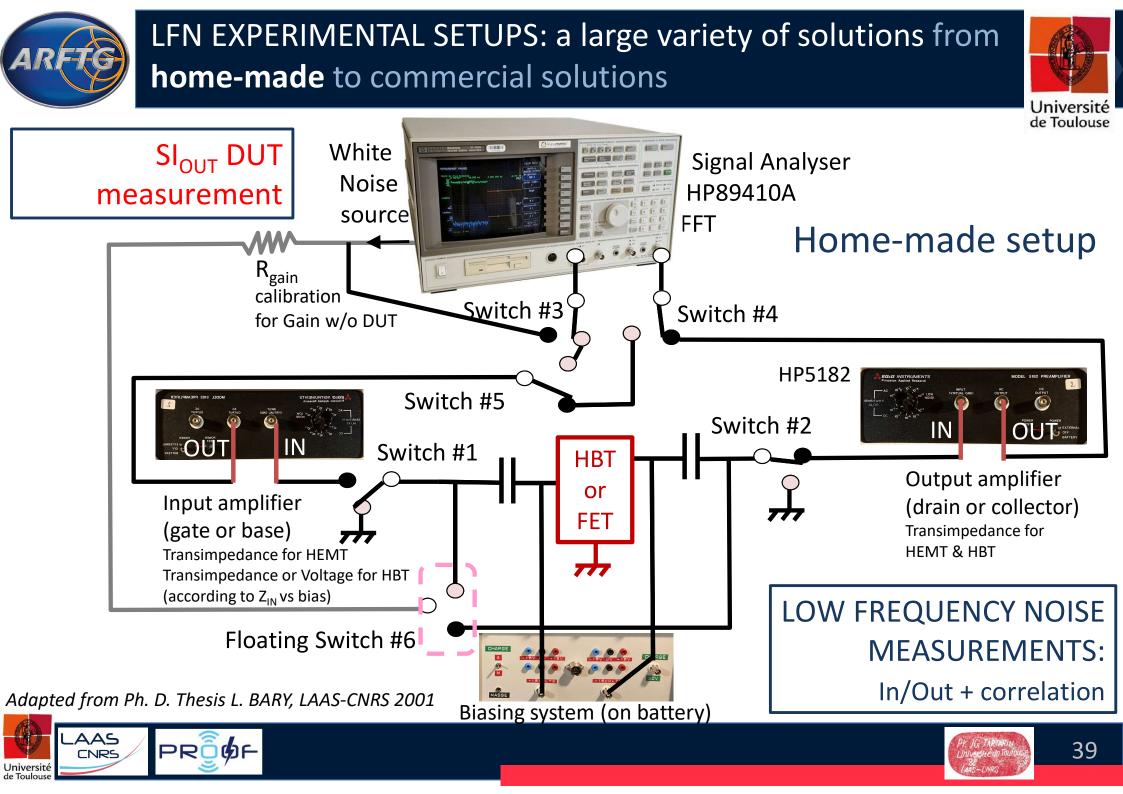












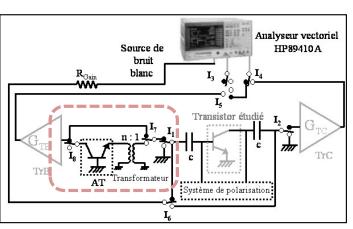


LFN EXPERIMENTAL SETUPS: a large variety of solutions from **home-made** to commercial solutions



Switch Meas. config.	SW1	SW2	SW3	SW4	SW5	SW6	SW7 Depending on configuration	SW8 Depending on configuration
Chain noise & gain	0	0	0	0	0	floating	Ð	8
Conversion gain of Input transimpedance G _{T_IN}	1	0	8	4	6	6	Ð	0
Conversion gain of Output transimpedance G _{T_OUT}	0	0	8	0	floating	0	0	0
S _{I-IN TA} measurement	1	2	0	4	6	floating	0	8
S _{I-OUT TA} measurement	0	2	0	4	0	floating	0	0
S _{I-IN,I-OUT*} cross-correlation measurement	1	0	0	0	0	floating	0	0





Nota : two more switches can be added to improve meas. on INPUT (between SW1 and Input amplifier-mainly Transimpedance) : using a transformer and a buffer amplifier. Lower input impedance as seen by the device at its input !

LOW FREQUENCY NOISE MEASUREMENTS: In/Out + correlation

THIS ALLOWS FOR S_{iout} and Correlation measurement

Adapted from Ph. D. Thesis L. BARY, LAAS-CNRS 2001







LFN EXPERIMENTAL SETUPS: many solutions to perform LFN and Impedance Measurement for noise correction



Nota : correlation of

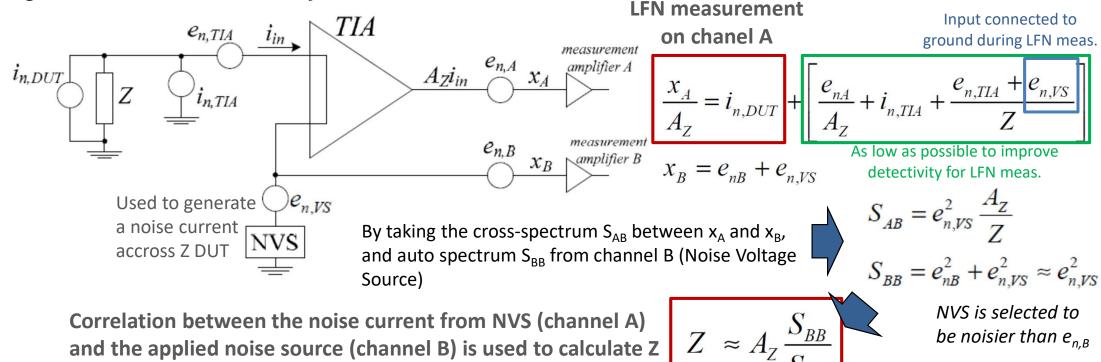
In/out LFN sources are

not accounted for here

Also cf. to Integrated Method for Impedance and Low Frequency Noise Measurements, G. Giusi, G. Scandurra and C. Ciofi IEEE Instrumentation and Measurement Society

Integrated method for LFN and Impedance Measurements (IMs) *IMs are performed by means of cross-correlation LFN measurements.*

Three-channel measurement system for the automatic DC, Gate or Drain low frequency noise, and impedance characterization of electron devices

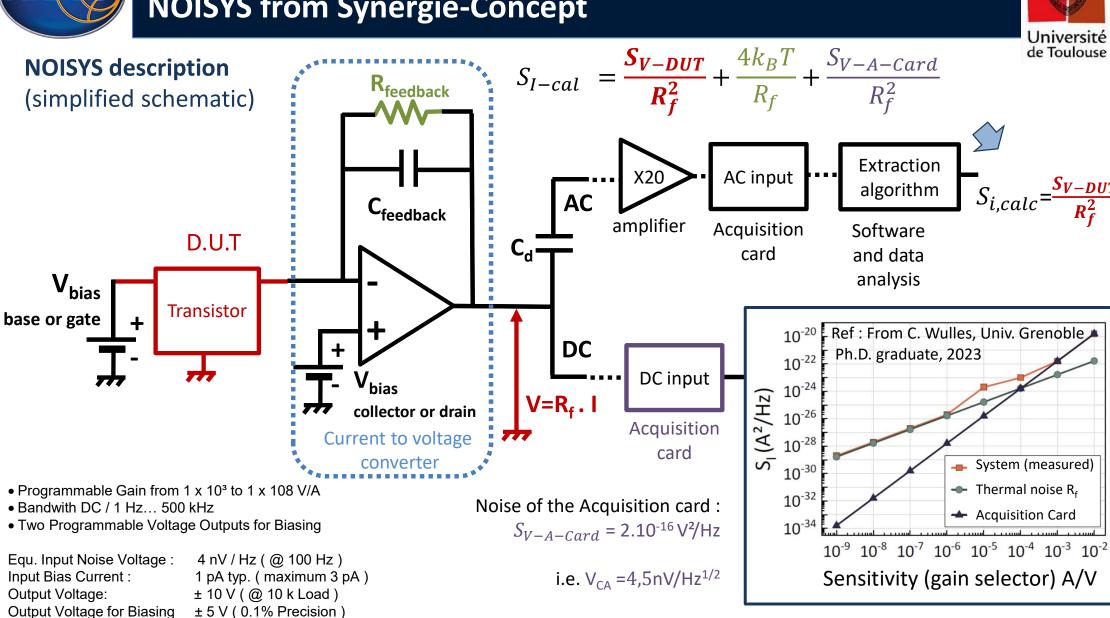


Ref: Giusi, IEEE International Instrumentation and Measurement Technology Conference (I2MTC), 2017









Ref: http://www.synergie-concept.fr/index_fichiers/Page1212.htm



50

Output Impedance :





LFN EXPERIMENTAL SETUPS: a large variety of solutions E4727B from Keysight



E4727B Advanced Low-Frequency Noise Analyzer

DCP-HTR Series Probe DCP 100 Series Probe

- Grounded probes closer to the device (limit ground loops from EMI/FRI) (GSG for RF devices for example, or dedicated probes with 1 contact)

- Shielded Environment Faraday or Probe station \rightarrow FormFactor's CM300xi-ULN probe station to addresse these measurements with low noise floor level (-190 dBVrms/Hz^{0,5} spectral noise)

Ref: htts://www.keysight.com/us/en/product/E4727B/e4727b-advanced-low-frequency-noise-analyzer.html Ref: https://www.formfactor.com/applications/semiconductor-r-d-test/low-frequency-noise/



What is said by Keysight

→ LNA for better sensitivity in low current biasing conditions
 → High power device noise measurement even in the high current
 like 1A (wide bandgap technologies at open channel operating modes)

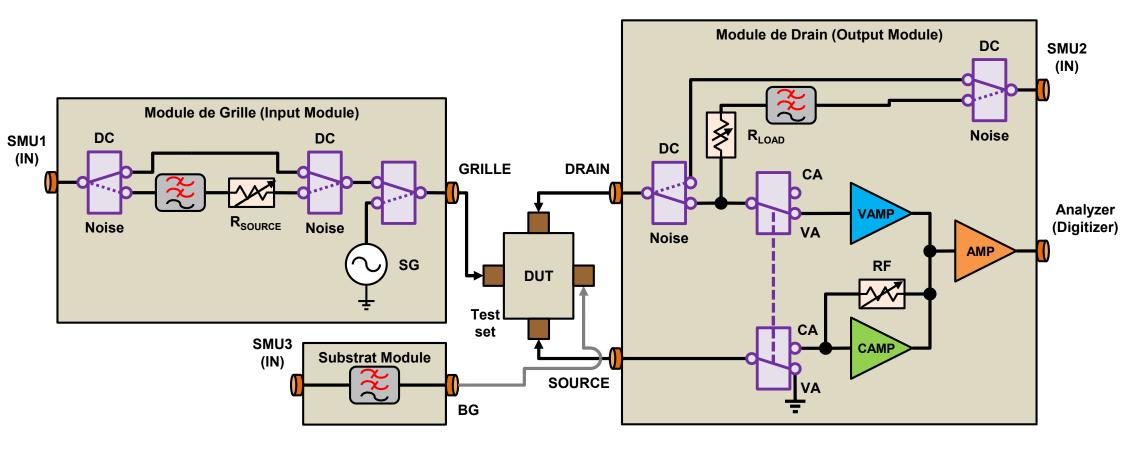






Université de Toulouse

E4727A or B Advanced Low-Frequency Noise Analyzer



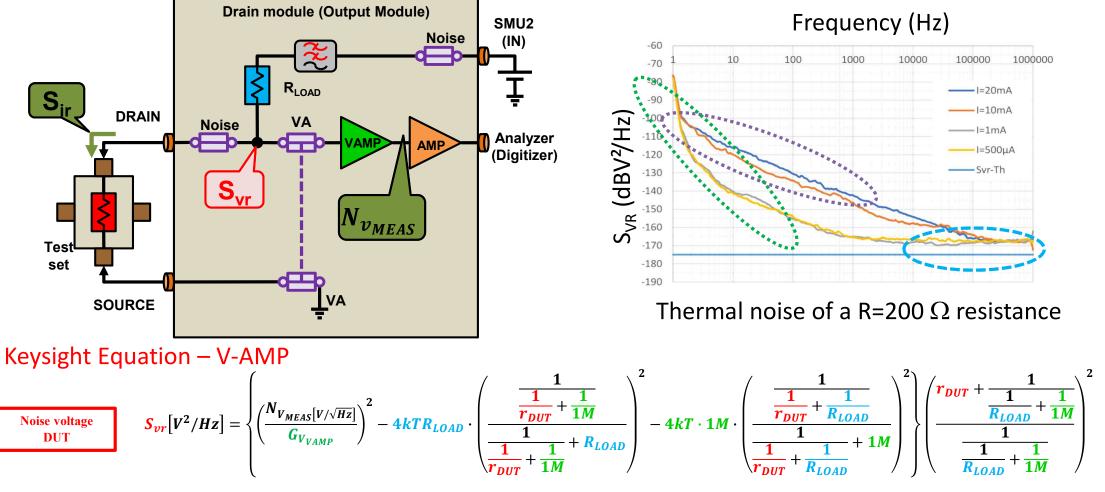
- LFNA as it is ! Commercialized version
- Development for Extended measurements limits and confidence interval studies by LAAS-CNRS







With modified equations (consideration of all noise sources of the setup) Calibration using a large set of Resistors and Diodes



All the considered noise sources are thermal noise





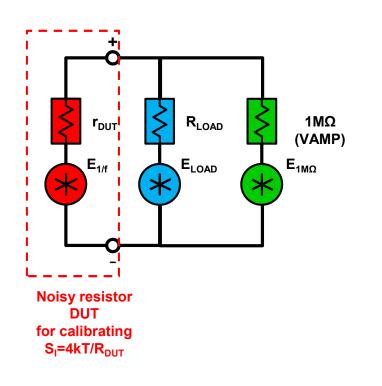


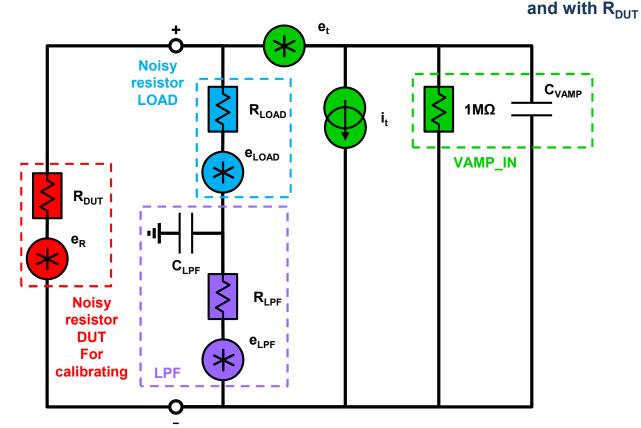


With modified equations (consideration of all noise sources of the setup) Calibration using a large set of Resistors and Diodes

Keysight equivalent model

Our complete chain representation using VAMP with noise sources at the input,





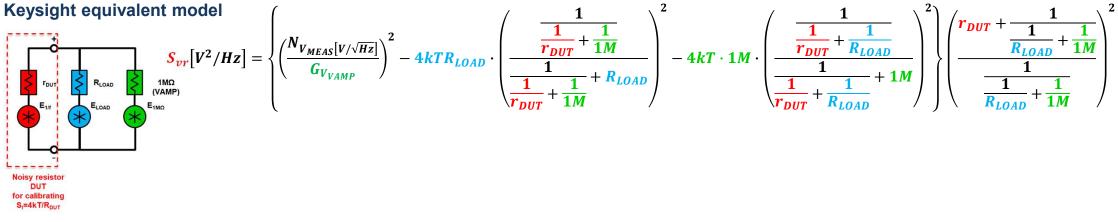
 e_t and i_t : noise sources voltage/current for VAMP e_R et e_{LOAD} : voltage noise sources for the noisy resistors R_{DUT} and R_{LOAD} e_{LPF} : voltage noise source for the resistor of the LPF



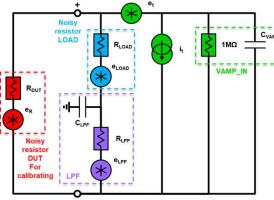




With modified equations (consideration of all noise sources of the setup) Calibration a large set of Resistors and Diodes



Our complete chain representation using VAMP with noise sources at the input, and with R_{DUT}



$$S_{vr}\left(\frac{V^{2}}{Hz}\right) = \left[\frac{N_{vmeas}^{2}\left(\frac{V^{2}}{Hz}\right)}{G_{v}^{2}} \cdot \left(1 + \frac{1}{|Z_{in}|} \cdot \frac{R_{Load} \cdot |Z_{DUT}|}{R_{Load} + |Z_{DUT}|}\right)^{2} - \left(e_{RLoad}^{2} + e_{SMU}^{2}\right) \cdot \left(\frac{|Z_{DUT}|}{R_{Load} + |Z_{DUT}|}\right)^{2} - e_{v}^{2} - i_{v}^{2} \cdot \left(\frac{R_{Load} \cdot |Z_{DUT}|}{R_{Load} + |Z_{DUT}|}\right)^{2} - 2Re\left\{e_{v} \cdot i_{v}^{*} \cdot \frac{R_{Load} \cdot |Z_{DUT}|}{R_{Load} + |Z_{DUT}|}\right\}\right] \cdot \left[\frac{R_{Load} + |Z_{DUT}|}{R_{Load}}\right]^{2}$$

VAMP noise sources should be determined for VAMP configuration (also with $e_v \cdot i_v^*$) Noise sources of SMU can be managed with Rload configuration in a certain limit ($R_{Load} >> |Z_{DUT}|$)







With modified equations (consideration of all noise sources of the setup) Calibration a large set of Resistors and Diodes

Integrated formula : LFNA from Keysight
$$s_{vr}[v^2/Hz] = \left\{ \begin{pmatrix} N_{vracel}(v/RE) \\ G_{vracer} \end{pmatrix}^2 - 4kTR_{Load} \cdot \left(\frac{1}{T_{DUT} + \frac{1}{M}} \right)^2 - 4kT \cdot 1M \cdot \left(\frac{1}{T_{DUT} + \frac{1}{R_{Load}}} \right)^2 - 4kT \cdot 1M \cdot \left(\frac{1}{T_{DUT} + \frac{1}{R_{Load}}} \right)^2 + 4kT \cdot 1M \cdot \left(\frac{1}{T_{DUT} + \frac{1}{R_{Load}}} \right)^2 + 4kT \cdot 1M \cdot \left(\frac{1}{T_{DUT} + \frac{1}{R_{Load}}} \right)^2 + 4kT \cdot 1M \cdot \left(\frac{1}{T_{DUT} + \frac{1}{R_{Load}}} \right)^2 + 4kT \cdot 1M \cdot \left(\frac{1}{T_{DUT} + \frac{1}{R_{Load}}} \right)^2 + 4kT \cdot 1M \cdot \left(\frac{1}{T_{Load} + 1M} \right)^2 + 4kT \cdot 1M \cdot \left(\frac{1}{T_{DUT} + \frac{1}{R_{Load}}} \right)^2 + 4kT \cdot 1M \cdot \left(\frac{1}{T_{DUT} + \frac{1}{R_{Load}}} \right)^2 + 4kT \cdot 1M \cdot \left(\frac{1}{T_{DUT} + \frac{1}{R_{Load}}} \right)^2 + 4kT \cdot 1M \cdot \left(\frac{1}{T_{DUT} + \frac{1}{R_{Load}}} \right)^2 + 4kT \cdot 1M \cdot \left(\frac{1}{T_{DUT} + \frac{1}{R_{Load}}} \right)^2 + 4kT \cdot 1M \cdot \left(\frac{1}{T_{Load} + \frac{1}{R_{Load}}} \right)^2 + 4kT \cdot 1M \cdot \left(\frac{1}{T_{Load} + \frac{1}{R_{Load}}} \right)^2 + 4kT \cdot 1M \cdot \left(\frac{1}{T_{Load} + \frac{1}{R_{Load}}} \right)^2 + 4kT \cdot 1M \cdot \left(\frac{1}{T_{Load} + \frac{1}{R_{Load}}} \right)^2 + 4kT \cdot 1M \cdot \left(\frac{1}{T_{Load} + \frac{1}{R_{Load}}} \right)^2 + 4kT \cdot 1M \cdot \left(\frac{1}{T_{Load} + \frac{1}{R_{Load}}} \right)^2 + 4kT \cdot 1M \cdot \left(\frac{1}{T_{Load} + \frac{1}{R_{Load}}} \right)^2 + 4kT \cdot 1M \cdot \left(\frac{1}{T_{Load} + \frac{1}{R_{Load}}} \right)^2 + 4kT \cdot 1M \cdot \left(\frac{1}{T_{Load} + \frac{1}{R_{Load}}} \right)^2 + 4kT \cdot 1M \cdot \left(\frac{1}{T_{Load} + \frac{1}{R_{Load}}} \right)^2 + 4kT \cdot 1M \cdot \left(\frac{1}{T_{Load} + \frac{1}{R_{Load}}} \right)^2 + 4kT \cdot 1M \cdot \left(\frac{1}{T_{Load} + \frac{1}{R_{Load}}} \right)^2 + 4kT \cdot 1M \cdot \left(\frac{1}{T_{Load} + \frac{1}{R_{Load}}} \right)^2 + 4kT \cdot 1M \cdot \left(\frac{1}{T_{Load} + \frac{1}{R_{Load}}} \right)^2 + 4kT \cdot 1M \cdot \left(\frac{1}{T_{Load} + \frac{1}{R_{Load}}} \right)^2 + 4kT \cdot 1M \cdot \left(\frac{1}{T_{Load}} + \frac{1}{T_{Load}} \right)^2 + 4kT \cdot 1M \cdot \left(\frac{1}{T_{Load}} + \frac{1}{T_{Load}} \right)^2 + 4kT \cdot 1M \cdot \left(\frac{1}{T_{Load}} + \frac{1}{T_{Load}} \right)^2 + 4kT \cdot 1M \cdot \left(\frac{1}{T_{Load}} + \frac{1}{T_{Load}} + \frac{1}{T_{Load}} + \frac{1}{T_{Load}} \right)^2 + 4kT \cdot 1M \cdot \left(\frac{1}{T_{Load}} + \frac{1}{T_{L$$

$$-e_{v}^{2}-i_{v}^{2}\cdot\left(\frac{R_{Load}\cdot|Z_{DUT}|}{R_{Load}+|Z_{DUT}|}\right)^{2}-2Re\left\{e_{v}\cdot i_{v}^{*}\cdot\frac{R_{Load}\cdot|Z_{DUT}|}{R_{Load}+|Z_{DUT}|}\right\}\right]\cdot\left[\frac{R_{Load}+|Z_{DUT}|}{R_{Load}}\right]^{2}$$



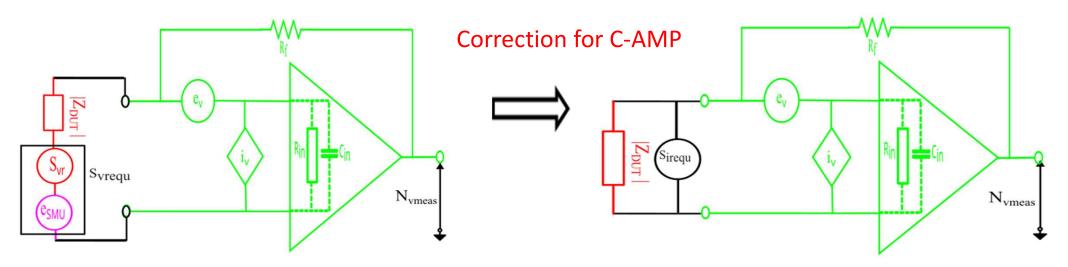




With modified equations (consideration of all noise sources of the setup) Calibration a large set of Resistors and Diodes

Integrated formula : LFNA from Keysight

$$S_{ia}(A^2/Hz) = \frac{N_{vmeas}^2(V^2/Hz)}{R_f^2}$$



Our full equation :

$$S_{iDUT}\left(\frac{A^{2}}{Hz}\right) = \frac{N_{vmeas}^{2}\left(\frac{V^{2}}{Hz}\right)}{R_{f}^{2}} \cdot \left[\frac{|Z_{in}| + |Z_{DUT}|}{|Z_{DUT}|}\right]^{2} - \frac{e_{SMU}^{2}}{|Z_{DUT}|^{2}} - i_{A}^{2} - \frac{e_{A}^{2}}{|Z_{DUT}|^{2}} - 2Re\left\{i_{A}^{*} \cdot \frac{e_{A}}{|Z_{DUT}|}\right\}$$

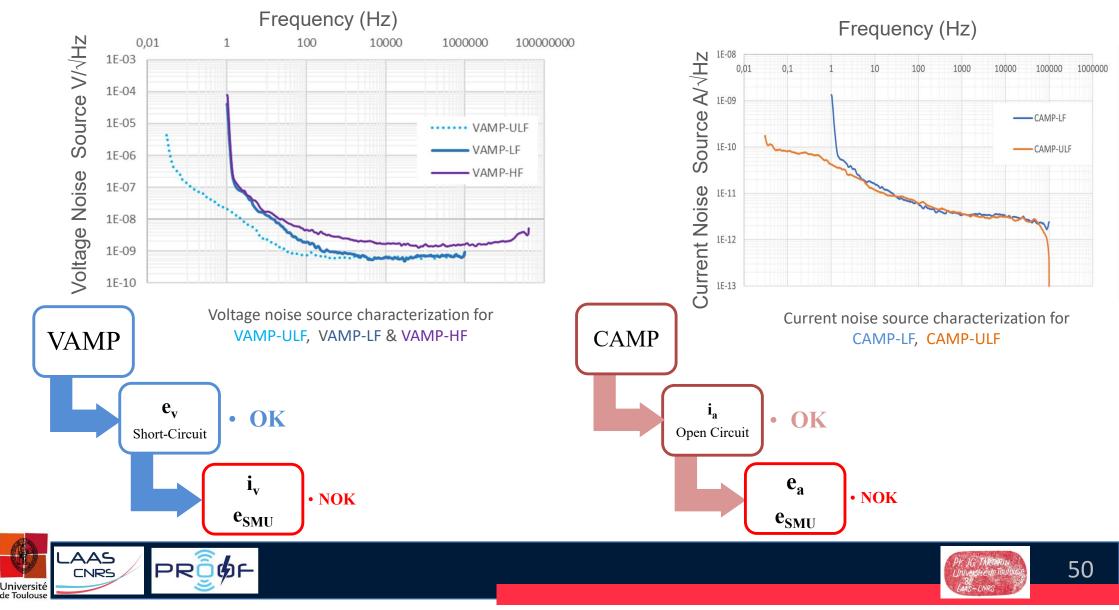




Université de Toulouse



With modified equations (consideration of all noise sources of the setup) Calibration of noise sources of V-AMP and C-AMP (needed for the extraction of the DUT noise source)

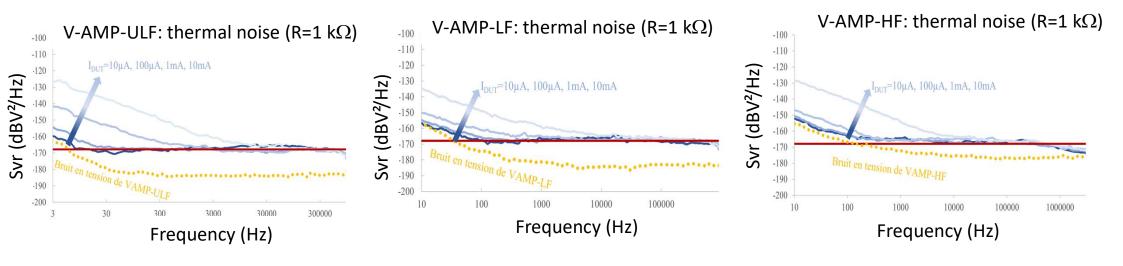




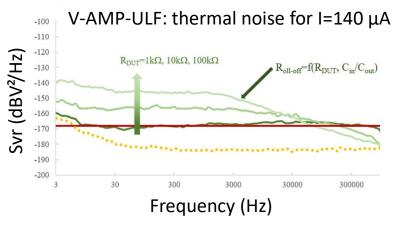


Interval of confidence for LFN measurements with E4727A

Calibration for thermal noise versus R, bias for V-AMP configurations



definition of a reliable data exploitation zone
 with template(∆f, noise floor) :
 Detection limit and DUT biasing impact on
 data post-processing



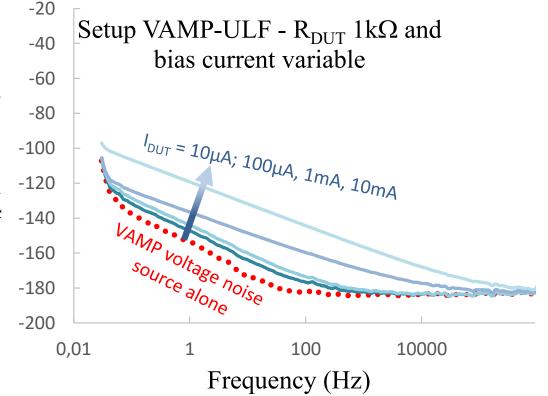






Interval of confidence for LFN measurements with E4727A





-measurements made with 2 SMUs : HP4142 and HP4156C -Resistance ranging from 100Ω , 470Ω ,..., $100k\Omega$, $470k\Omega$, $1M\Omega$ - 2 Diodes : PH4148 & 1N 4007

Set the interpretable and reliable measurement limits



Example for V-AMP LF configuration

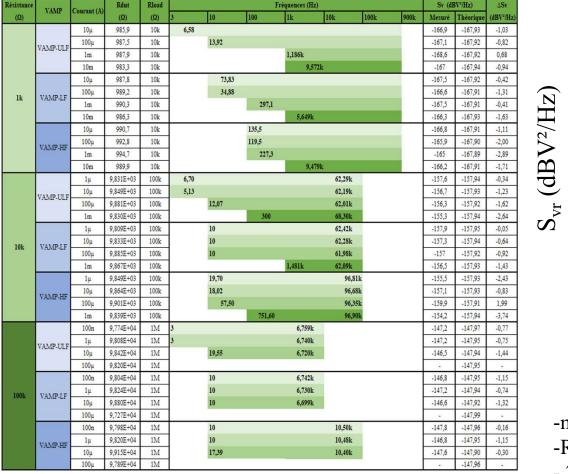


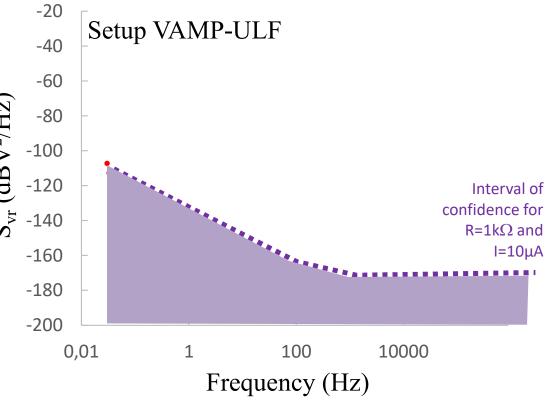
Université de Toulouse





Interval of confidence for LFN measurements with E4727A





-measurements made with 2 SMUs : HP4142 and HP4156C -Resistance ranging from 100Ω , 470Ω ,..., $100k\Omega$, $470k\Omega$, $1M\Omega$ - 2 Diodes : PH4148 & 1N 4007

Set the interpretable and reliable measurement limits



Example for V-AMP LF configuration





LFN EXPERIMENTAL SETUPS: a large variety of solutions from **home-made** to **commercial solutions**



		W7802B PathWave WaferPro Express Measurement and Programin bundle		W7801B PathWave WaferPro Express WGFMU Measurement bundle	Home made setup LAAS-CNRS (batteries)		
Measurement Hardware		E4727B A-LFNA	B1500A with B1530A WGFMU		Х		
Target Device		FET, BJT, Diode, Resistor, Circuit	FET		FET, HBT (BJT), Diode, circuit (depending on RF-DC decoupling)		
Device Terminal Number		3, 4, 5, 6	3		3		
Maximum Bias V	Voltage According the gain of	+200 V	±10 V		Limited by batteries (60 V) - SMUs can be used with degraded perf.		
Maximum Bias Current each V or		100 0	±10 mA		250 mA		
Noise Floor amplifier			1E-25 A ² /Hz		S_I : typ 1E -24 A ² /Hz, down to 2E -28 A ² /Hz S _V : typ 1E -17 V ² /Hz Downto 1E-19V ² /Hz		
Analog Frequency Bandwidth (feedback		30 mHz – 100 MHz	1 mHz – 16 MHz		1 Hz – 100 MHz		
Frequency Domain Measurement	Min Frequency	30 mHz		1 mHz	1 Hz		
	Max Frequency	100 MHz	Hz 16 MHz		100 MHz		
Time Domain Measurement	Max Sampling Frequency	500 MHz	200 MHz		FFT on with Signal Analyzer (Takeda		
	Min Sampling Interval	2 ns	5 ns				
	Max Sampling Number	16,777,216(=2 ²⁴)	1	2,097,152(=2 ²¹)			
Controller PC		M9037A Embedded Controller		Windows PC	Windows – C++		
GP-IB Interface		M9037A Built-in GP-IB interface (Micro-D 25pin)		USB GP-IB Interface (Keysight 82357B, NI GPIB-USB-HS)	CD ID interface		

SRS preamplifier SR570 gives S₁ as low as 25 10⁻³⁰ A²/Hz (limited to 1-60 Hz bandwidth!)

Noise floor must be carefully interpreted ! This is without DUT / biasing systems





54



FLECTRONIC NOISE: in France and at LAAS-CNRS

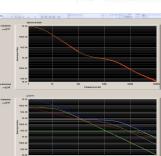
LOW FREQUENCY NOISE (LFN) : metrological niche ? Not only !

LFN EXPERIMENTAL SETUPS: a large variety of solutions from home-made to commercial solutions

APPLICATIONS OF LFN MEASUREMENTS : defect detection, reliability analysis, non-linear RF circuit design (VCOs, Mixers).













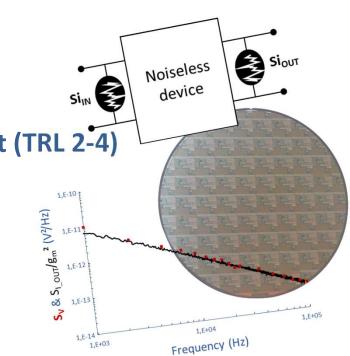
Emerging Technologies / Defect detection & Reliability Analysis

#1 : Noise Theory, is there some new 'hot' topics ?

#2 :Defect Detection for Technological development (TRL 2-4)

#3 : Failure Analysis in RF Devices (TRL 3-7)

#4 : Failure Analysis in RF Devices (part 2)



LFN for non-linear RF circuit design (VCOs, Mixers).







AAS

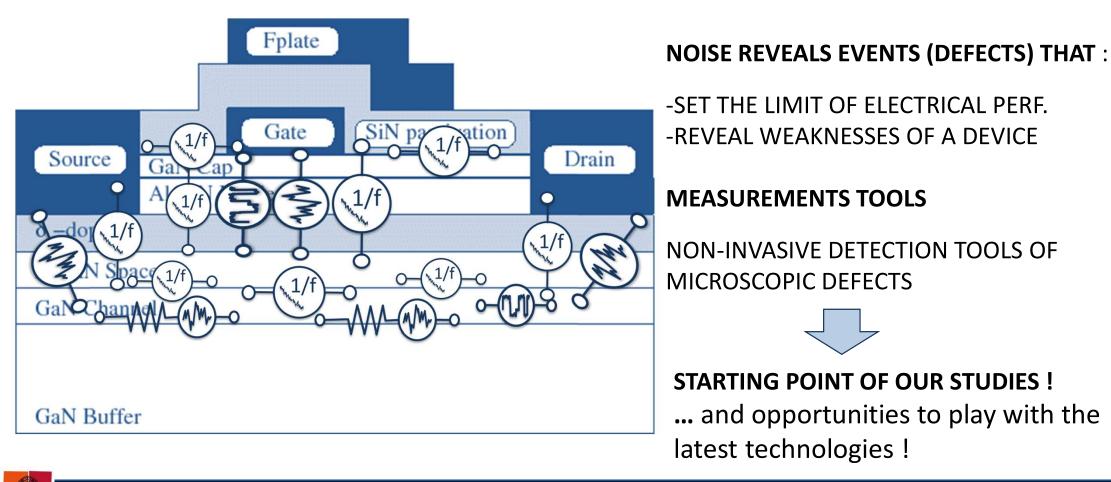
PRODF



Electrical improvement by frequency & power increase

→ various technologies (III-V, SiGe, GaN, ...)

→ various active devices (HBT, LDMOS, MESFET, HEMT, m/pHEMT, FinFET, nanoFET...)









Electrical improvement by frequency & power increase

→ various technologies (III-V, SiGe, GaN, ...)

→ various active devices (HBT, LDMOS, MESFET, HEMT, m/pHEMT, FinFET, nanoFET...)



BLIND TEST ON TECHNOLOGY

NOISE REVEALS EVENTS (DEFECTS) THAT :

-SET THE LIMIT OF ELECTRICAL PERF. -REVEAL WEAKNESSES OF A DEVICE

MEASUREMENTS TOOLS

NON-INVASIVE DETECTION TOOLS OF MICROSCOPIC DEFECTS

STARTING POINT OF OUR STUDIES !

... and opportunities to play with the latest technologies !

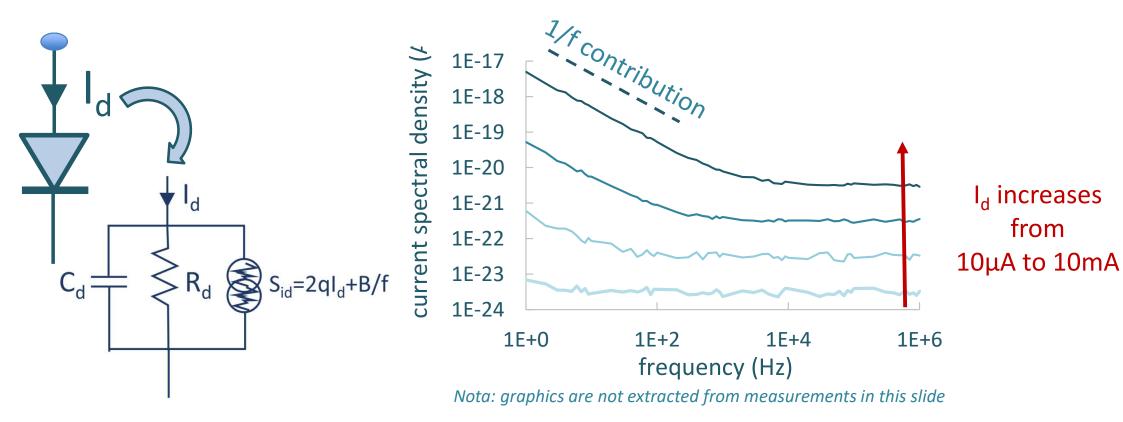








Shot noise is massively used for noise design in (complex) solid state devices, and very easy to formulate if frequency is not very high



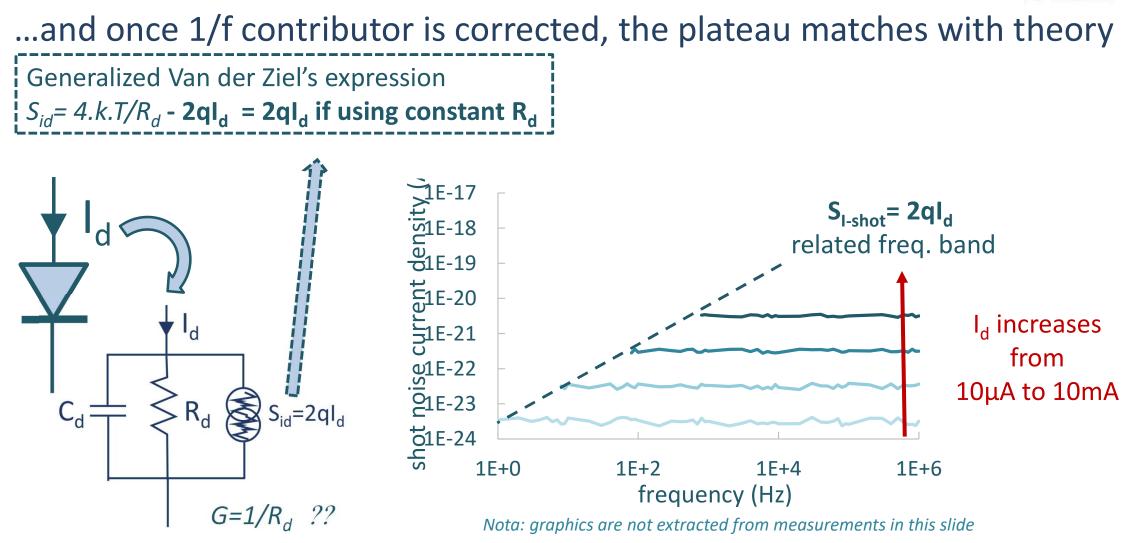






#1: Noise Theory (part 1) Evidence of the noise floor enhancement: deviation from the Schottky theory







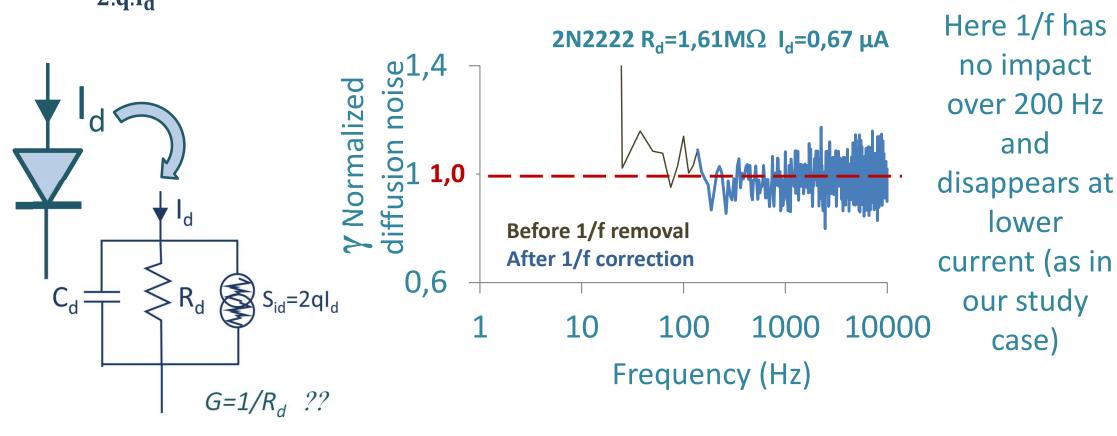




#1:Noise Theory (part 1) <u>Evidence of the noise floor enhancement: deviation from the Schottky theory</u>



...and once 1/f contributor is corrected, the plateau matches with theory $\gamma = \frac{S_{id}(f)}{2.q.L_d} = 2.U_t.G/I_d - 1 = 1 @ LF$





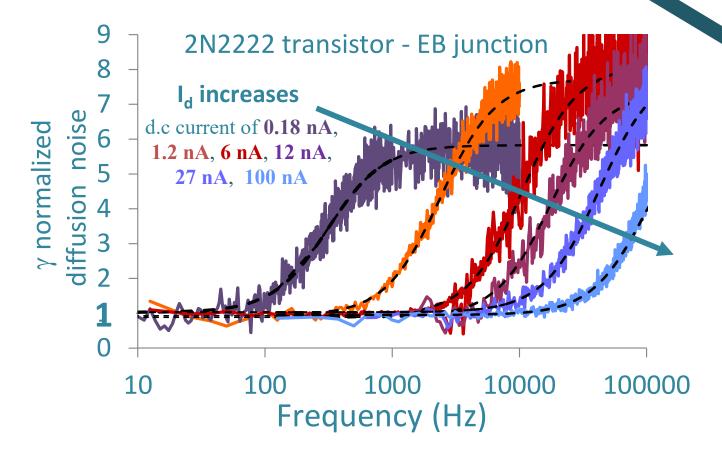




Evidence of the noise floor enhancement: deviation from the Schottky theory



But under specific very low biasing conditions, an enhancement occurs vs frequency ! Using the normalized form



 $\frac{S_i(f)}{2.q(I_d+2I_S)}$

Nota: saturation current is considered as in Van der Ziel' expression





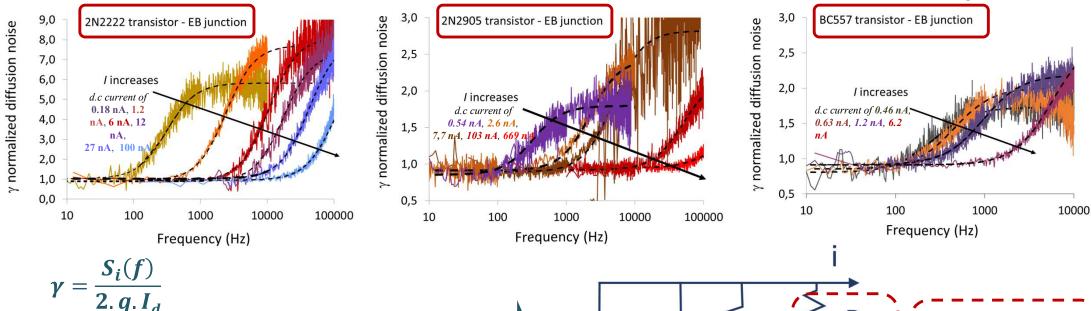


Evidence of the noise floor enhancement: deviation from the Schottky theory



Measurement of various diodes; model of the noise floor enhancement phenomenon

Evolution of the plateau magnitude and corner frequency with I_d



C_d

A noise model can be developed to satisfy the LFN measurements with noisy R_{add} in parallel with C_{add}

Ref: Graffeuil, Escotte, Tartarin, IEEE ICNF 2019





 $S_{i add} = 4kT/R_{add}$

 $S_{e add} = 4kTR_{add}$

 $\mathsf{R}_{\mathsf{add}}$

 e_{add}

777



Evidence of the noise floor enhancement: deviation from the Schottky theory



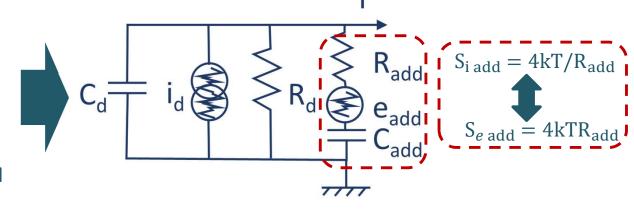
Measurement of various diodes; model of the noise floor enhancement phenomenon

Expression of S_i

$$S_{i}(f) = \begin{bmatrix} S_{id} \end{bmatrix} + \frac{(C_{add}, \omega)^{2} S_{iadd}}{(1 + (R_{add}C_{add}\omega)^{2})} \qquad \text{for } \omega \to 0 \qquad S_{i}(f) = S_{id}$$
$$for \ \omega \to \infty \qquad S_{i}(f) = S_{id} + S_{iadd} = S_{id} + 4kT/R_{add}$$

 R_{add} is noisy and associated in a serial representation with C_{add} So R_{add} - C_{add} cannot be attributed to a (deep) trap phenomenon (Veddel 1997, Jensen 2006)

A noise model can be developed to satisfy the LFN measurements with noisy R_{add} in parallel with C_{add}









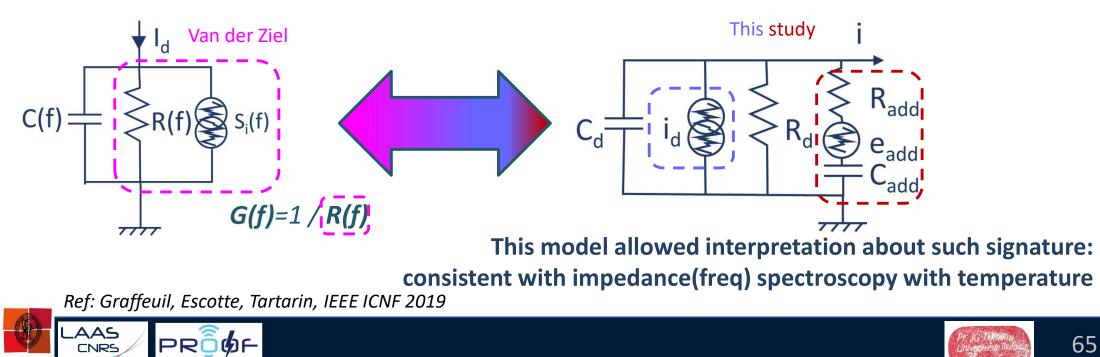
Evidence of the noise floor enhancement: deviation from the Schottky theory



This model is fully compatible with the Van Der Ziel expression

Generalized Van der Ziel's expression $S_{l}(f) = 4.k.T./R(f) - 2ql_{d}$

R(f) stands for the frequency behavior of the R_d **,** C_d **,** R_{add} **,** C_{add} **network** But is not used neither in the CAD soft. (noise models of diodes), nor in the usual models (-it was not necessary to use it till then-) where $S_{id} = 2qI_d$ applies

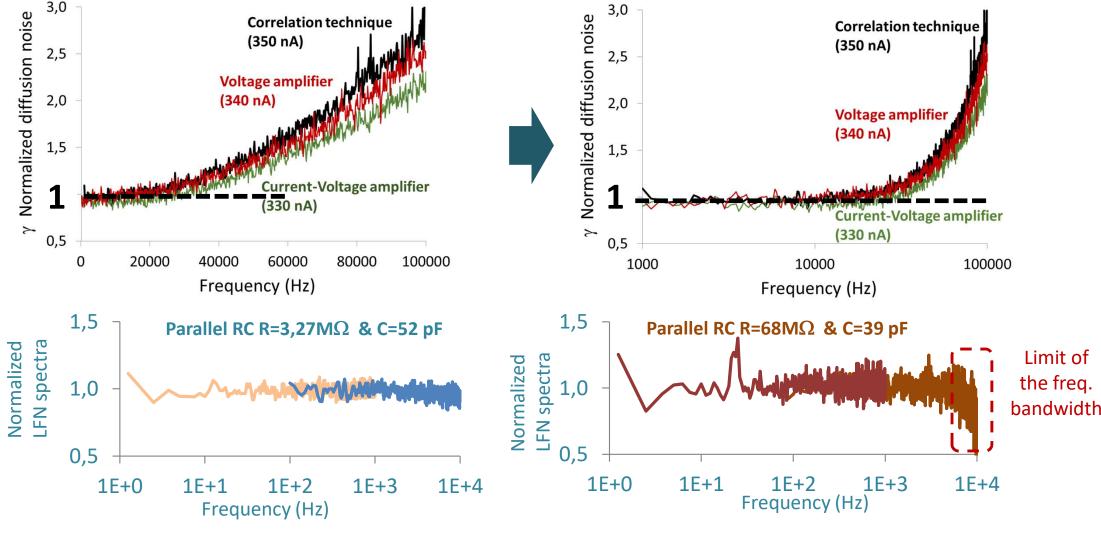




Evidence of the noise floor enhancement: deviation from the Schottky theory



Experimental setups and measurement validation







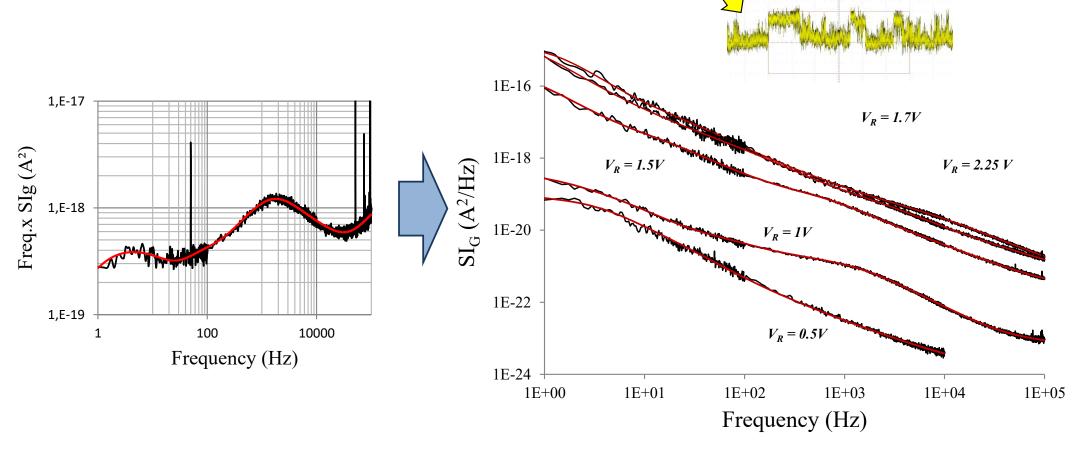


GR centers for traps spectroscopy: energy and location of traps



LFN on gate terminal: the command of the HEMT GaN high frequency transistors

- Gate access : charges distribution under the gated zone affects I_{DS} (and I_{GS})
- Transient and harmonic evaluation of charges, GR centers and RTN (not discussed here).





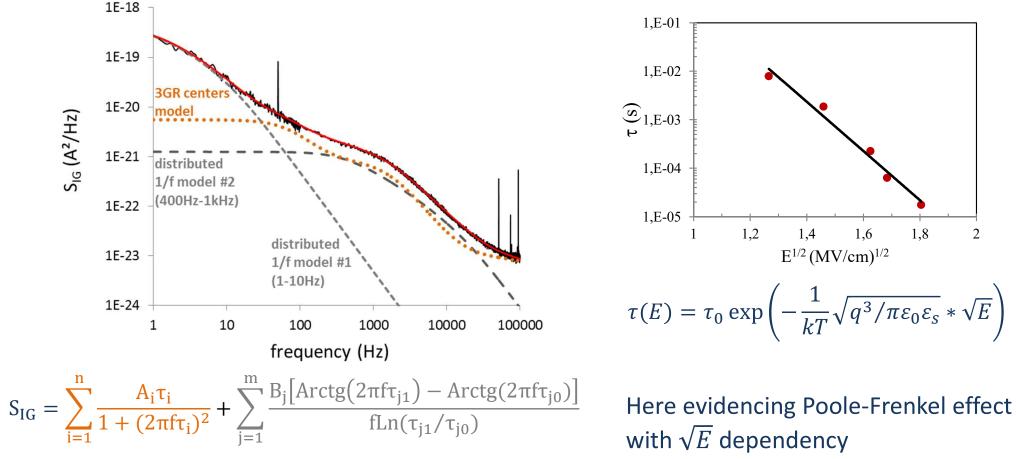


GR centers for traps spectroscopy: energy and location of traps



LFN on gate terminal : the command of the HEMT GaN high frequency transistors

GR centers tracking : identification of bias dependant time constants ranging between 10 µs and 10 ms (also using C-V measurements to extract E-field)







1.6

1,8

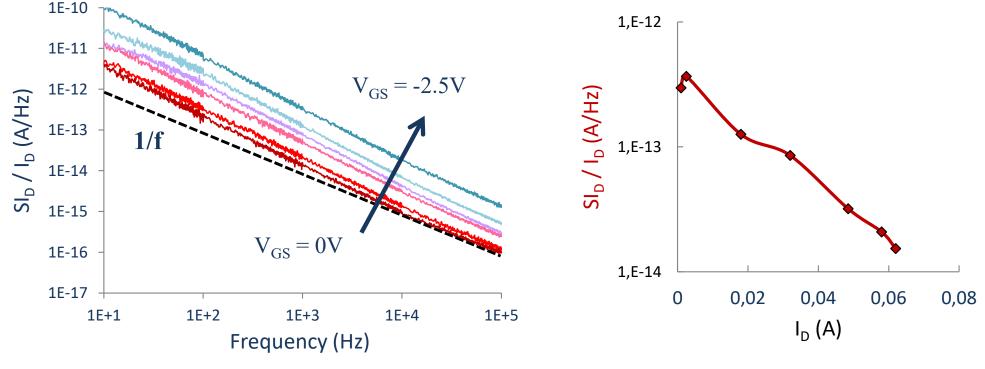
2



GR centers for traps spectroscopy: energy and location of traps

LFN on drain terminal: defects in the 2DEG, but is this detrimental to proper functioning?

• S_{ID} vs V_{GS} and V_{DS} also reveals the presence of distributed GR centers : which impact ?



Neither a 1/f trend, nor $1/f^{\gamma}$ frequency dependency

 S_{ID}/I_D decreases when I_{DS} increases \rightarrow monotoneous behavior

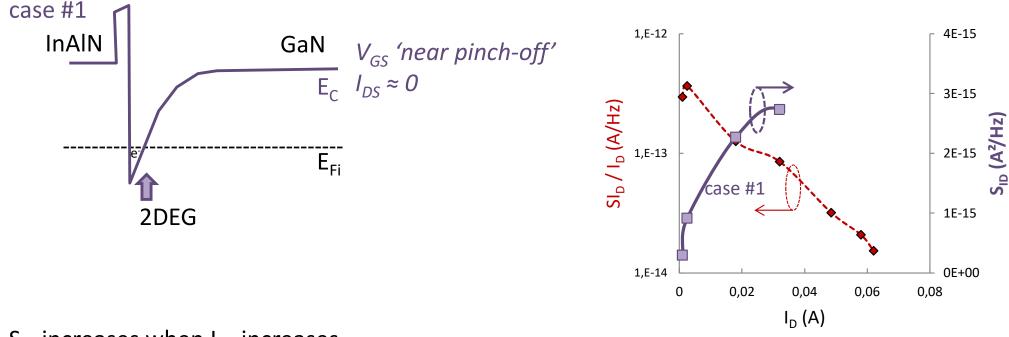




GR centers for traps spectroscopy: energy and location of traps

LFN on drain terminal: defects in the 2DEG, but is this detrimental to proper functioning?

• S_{ID} vs V_{GS} and V_{DS} also reveals the presence of distributed GR centers : which impact ?



 $S_{\rm ID}$ increases when ${\rm I}_{\rm DS}$ increases

But S_{ID}/I_D decreases (effects of 'defects' on carriers in the 2DEG are less effective !)

WHY?

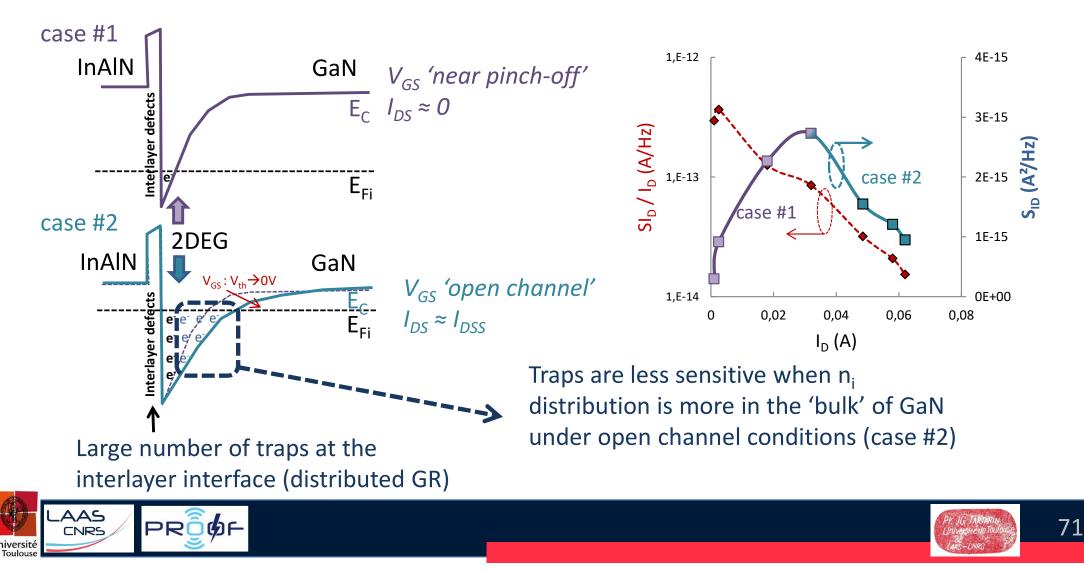


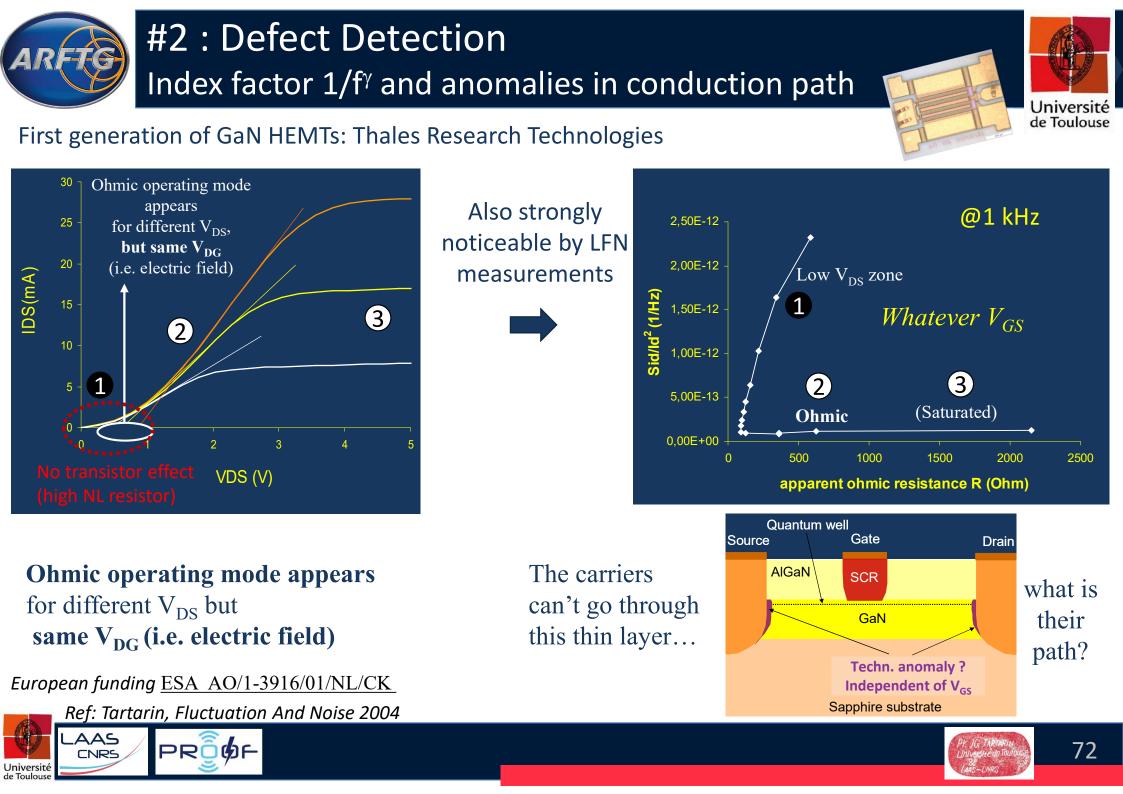


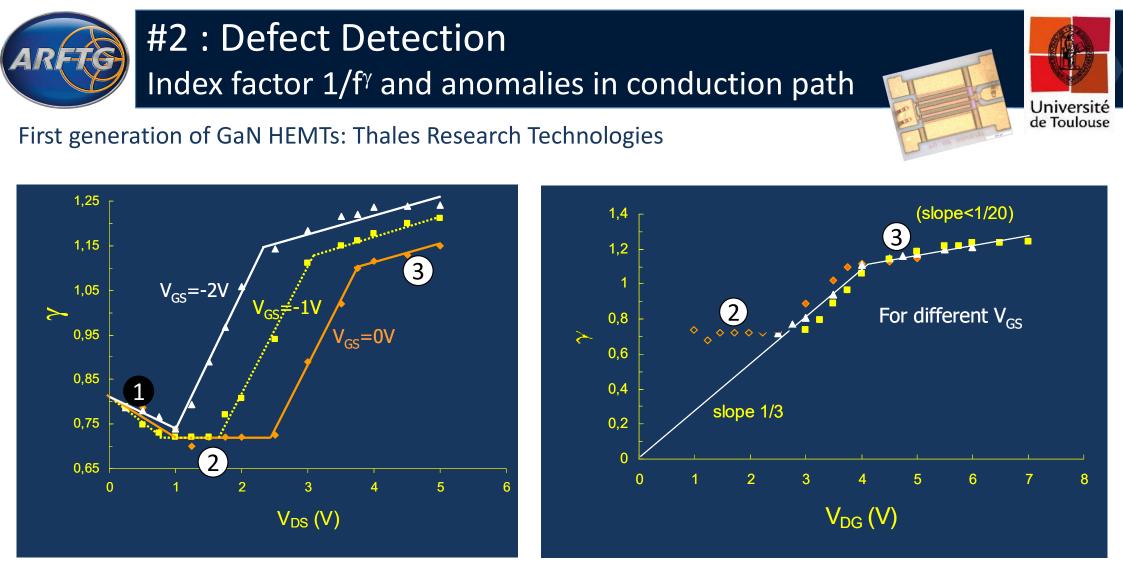
GR centers for traps spectroscopy: energy and location of traps

LFN on drain terminal: defects in the 2DEG, but is this detrimental to proper functioning?

• S_{ID} vs V_{GS} and V_{DS} also reveals the presence of distributed GR centers : which impact ?







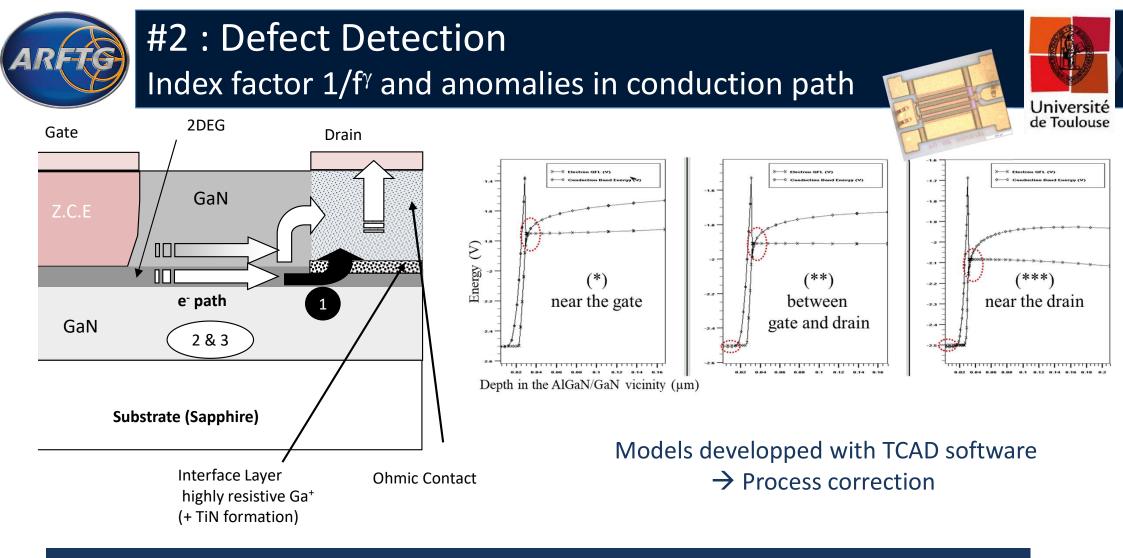
Index factor γ (1/f $^{\gamma}$) lower than 1 (noticed for the first time) Study on mechanisms of conduction in parallel layers

European funding ESA AO/1-3916/01/NL/CK

Ref: Tartarin, Fluctuation And Noise 2004







Example for LFN for defect detection and technological development

Also used for HBT (GaInP/GaAs, GaAlAs/GaAs, SiGe, CMOS...), and FET (GaN HEMT)



PRODF

AAS

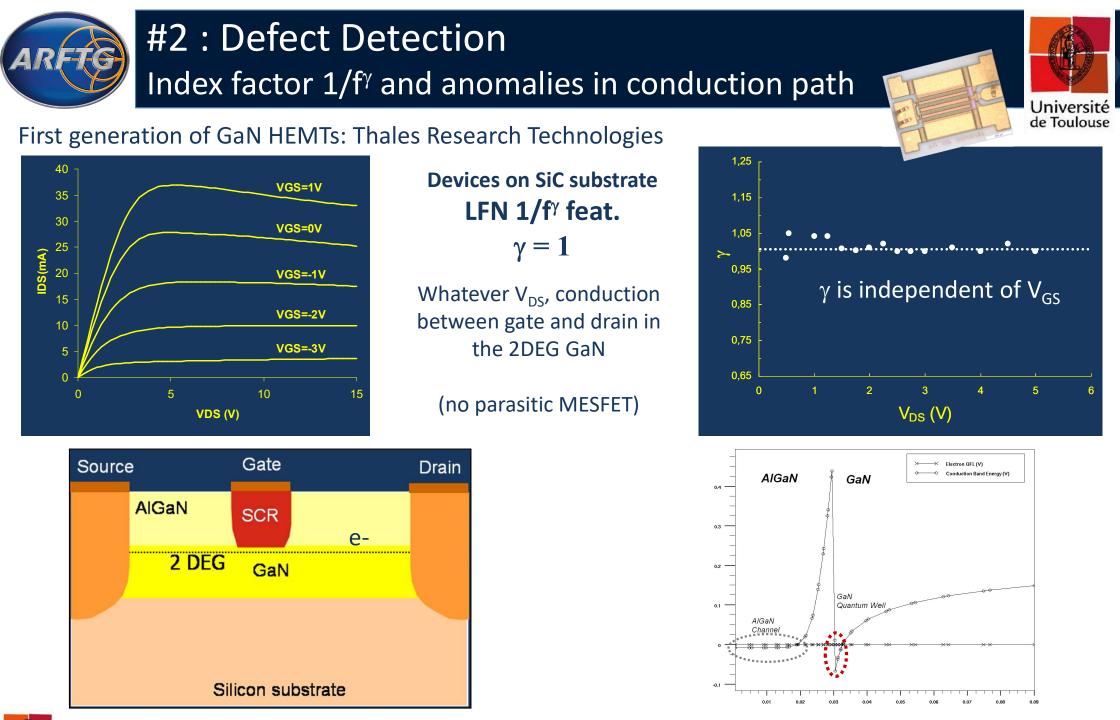
CNRS

Ref: Tartarin, Fluctuation And Noise 2004

3 European Programs and 10 National Programs Cooperations with foundries from the United States, Canada and Taiwan



74





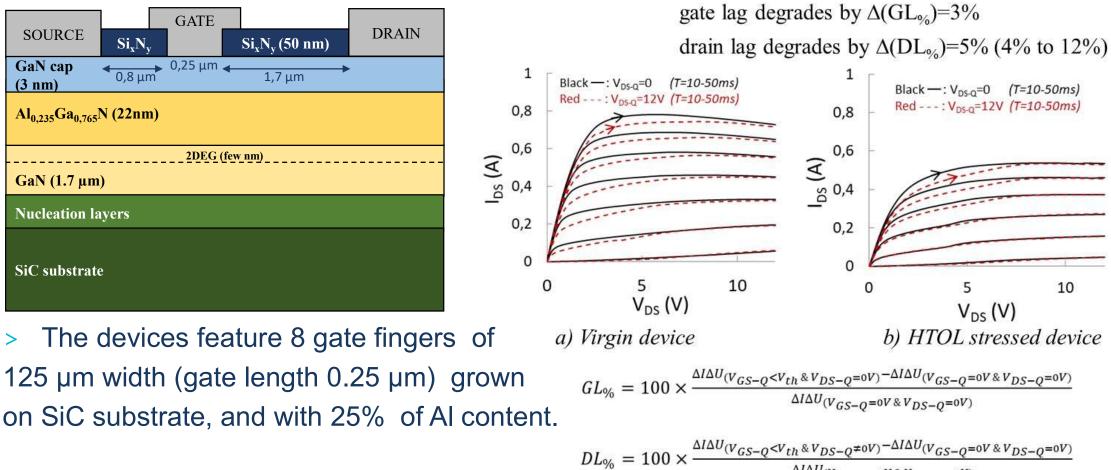






GaN HEMT structure

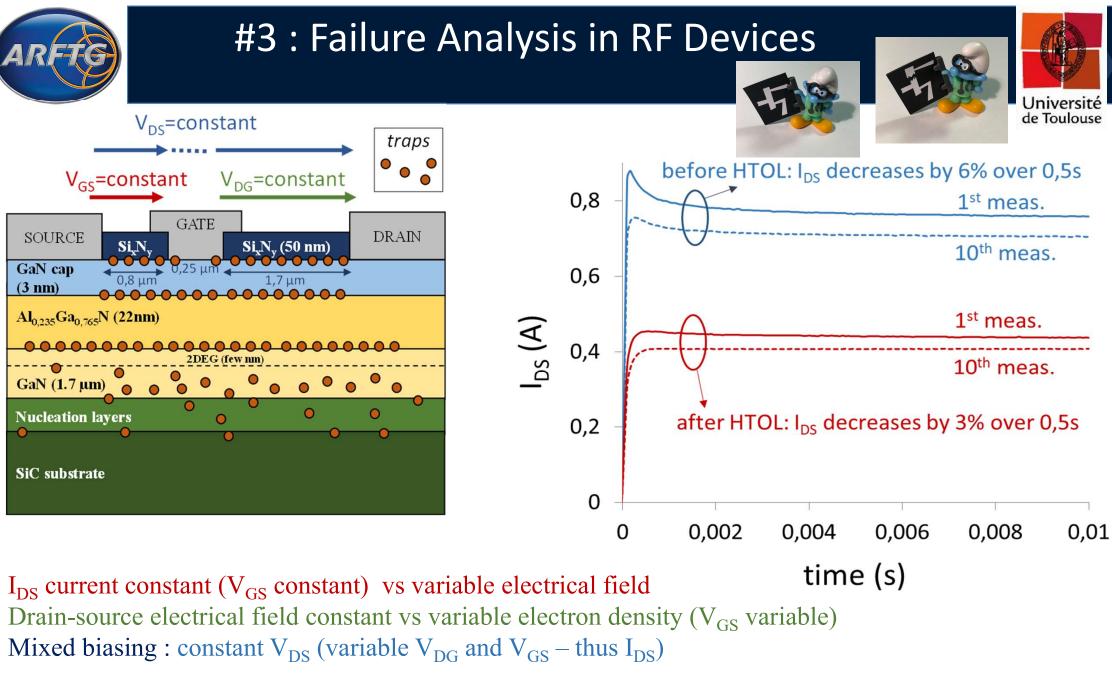
\rightarrow Process during development phase (Now qualified & commercially available)



 $\Delta I \Delta U_{(V_{GS-Q}=0V \& V_{DS-Q}=0V)}$

ANR Funding, French DoD funding





ANR Funding, French DoD funding





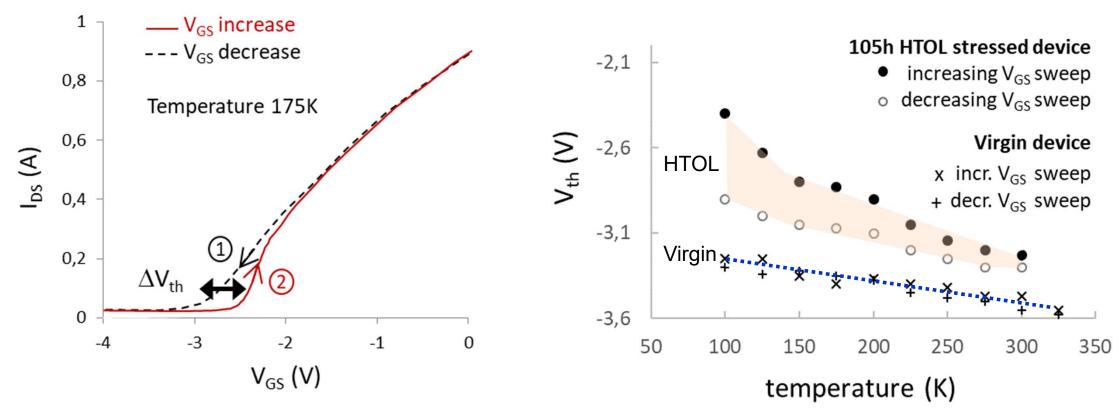






Thermal characterization: V_{th} drift (increasing and decreasing V_{GS} sweeps)

 \bullet V_{th} also depends on the sweeping conditions for V_{GS} (increasing/decreasing $V_{GS})$



ANR Funding, French DoD funding





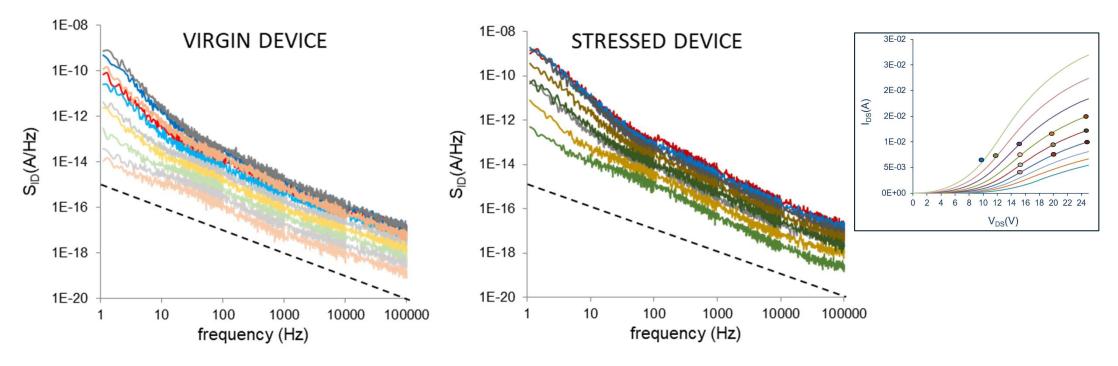




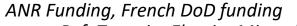


Evidence of traps with LFN & RTN characterization (study on PBTI drifts in HEMT GaN devices.

• LFN & RTN characterizations on Drain and Gate ports



Presence of traps in the 2DEG but no major influence of the HTOL stress on their evolution







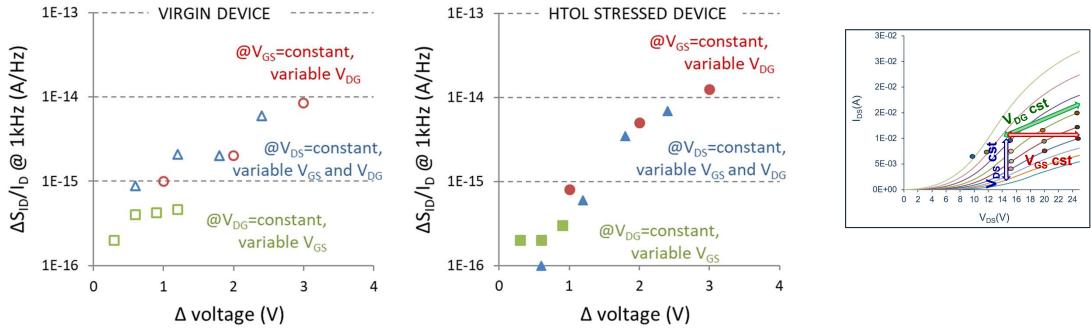






Evidence of traps with LFN & RTN characterization (study on PBTI drifts in HEMT GaN devices.

• LFN & RTN characterizations on Drain and Gate ports



Activation of traps (normalized spectral density) in the 2DEG with electrical field distribution **G-D** (& G-S) BUT no major difference between VIRGIN & STRESSED devices

ANR Funding, French DoD funding

PRODE

AAS

CNRS

 $I_{DS} \text{ current constant (V}_{GS} \text{ constant) vs variable electrical field } \\ Drain-source electrical field constant vs variable electron density (V}_{GS} \text{ variable}) \\ Mixed biasing : constant V_{DS} (variable V_{DG} \text{ and } V_{GS} - thus I_{DS}) \\ \end{cases}$



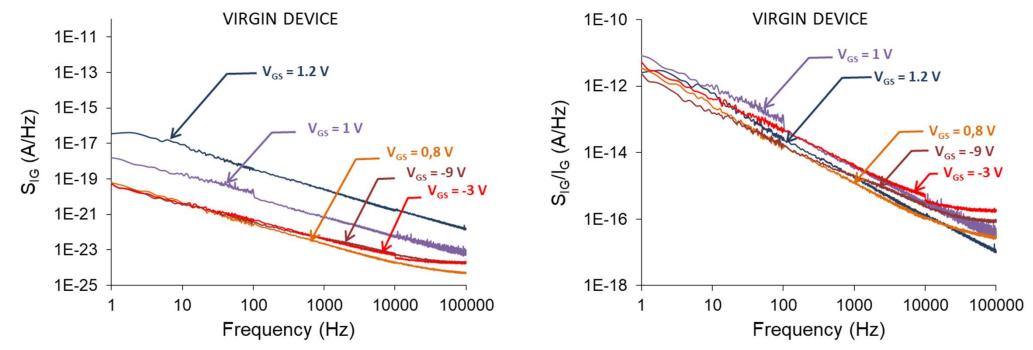






Evidence of traps with LFN & RTN characterization (study on PBTI drifts in HEMT GaN devices).

• LFN & RTN characterizations on Drain and Gate ports



Normalized S_{IG} LFN spectral density features almost stable signature on VIRGIN devices vs V_{GS}







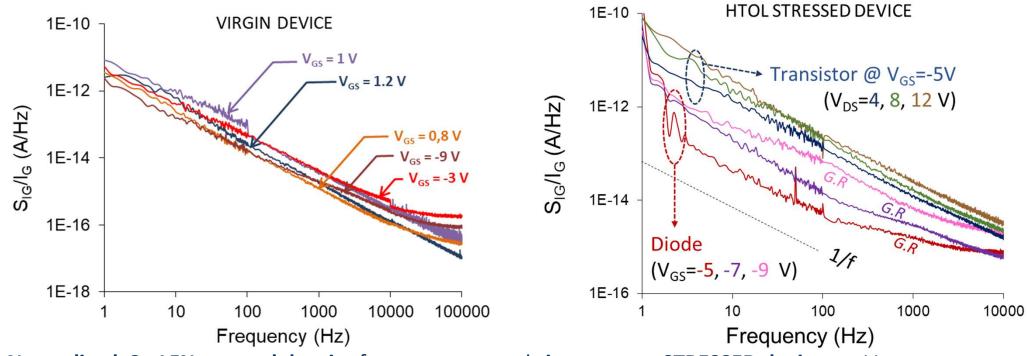






Evidence of traps with LFN & RTN characterization (study on PBTI drifts in HEMT GaN devices.

• LFN & RTN characterizations on Drain and Gate ports



Normalized S_{IG} LFN spectral density features scattered signature on STRESSED devices vs V_{GS} Evidence of new traps activated on the G-S path, with various act. mode (diode/transistor)



PRÔØF

AAS



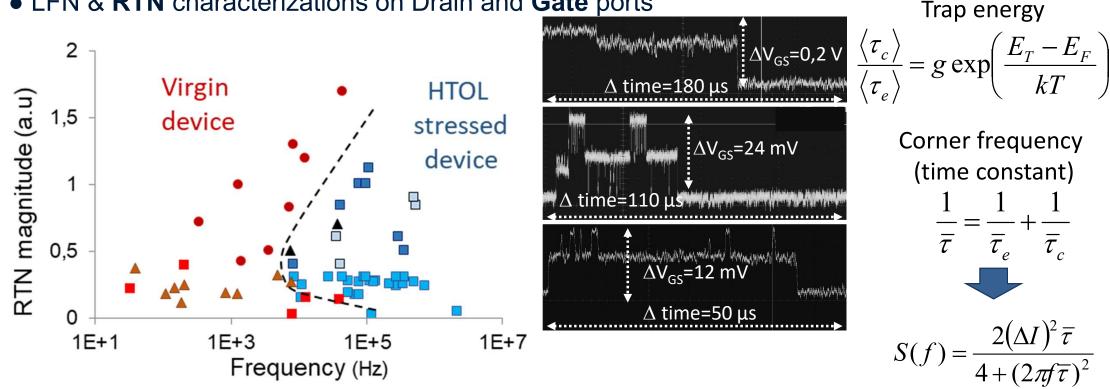






Evidence of traps with LFN & RTN characterization (study on PBTI drifts in HEMT GaN devices.

• LFN & RTN characterizations on Drain and Gate ports



RTN time constants (noise corner frequency) delimitation between VIRGIN and STRESSED devices



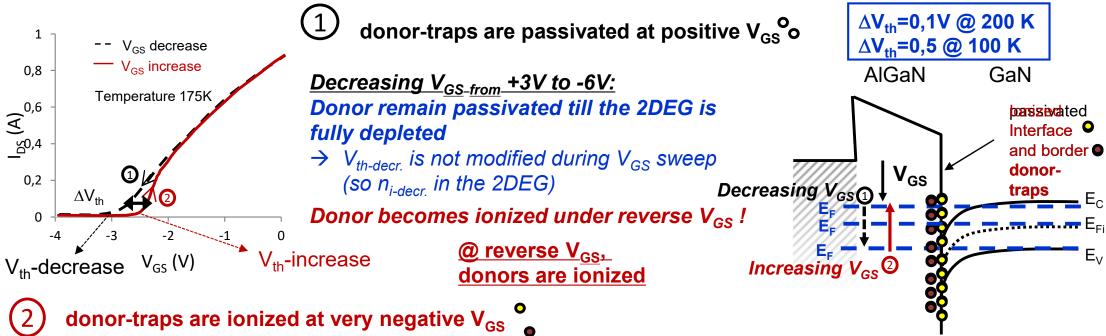








Evidence of traps with LFN & RTN characterization (study on PBTI drifts in HEMT GaN devices.)



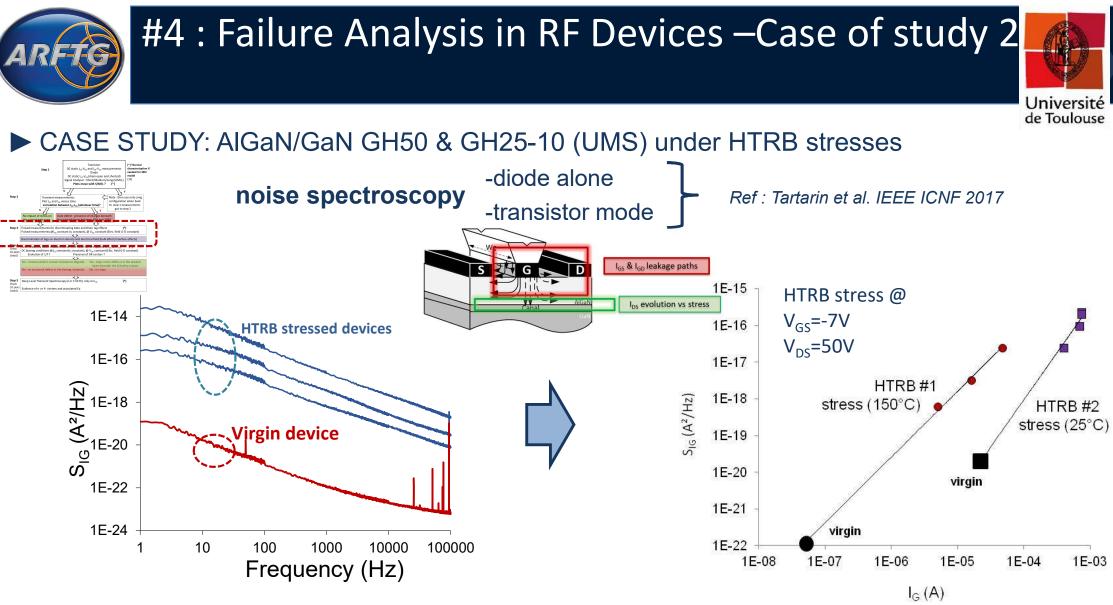
Increasing V_{GS} from -6V to +3V:

<u>Donor are ionized (N_D^+) at very low V_{GS} </u>. These positive charges act as an internal generator which field is opposite to the applied voltage V_{GS} , and $V_{th-incr.} > V_{th-decr.}$ (thus $n_{i-incr.} < n_{i-decr.}$), till $V_{th-incr.}$. When the 2DEG starts to conduct electrons, ionized donor-traps recombine with electrons from the 2DEG (few electrons that do not change ni), and become passivated</u>. The internal generator disappears and V_{th} changes to a lower value as for the decreasing sweep)

ANR Funding, French DoD funding







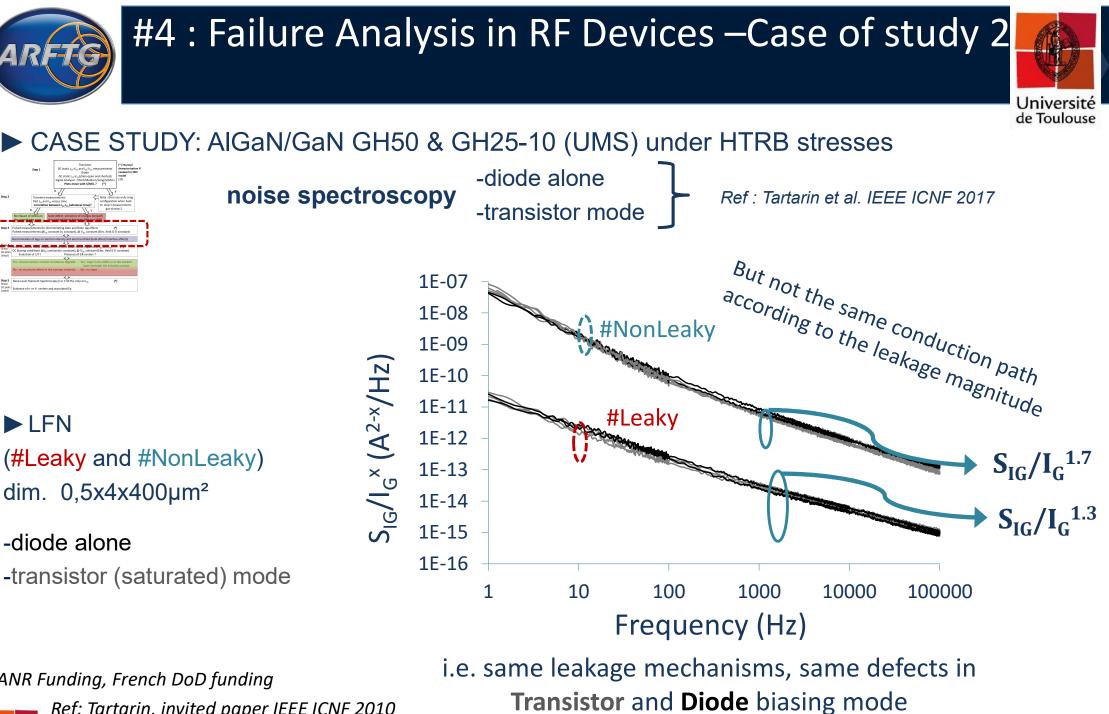
Leakage current as marker of failure events ! S_{ig} also gives a finest signature of carrier's path/interactions in the control zone and lateral/vertical leakage zones

ANR Funding, French DoD funding

Ref: Int. Conference on Noise and Fluctuation (ICNF) 2011, Toronto, invited paper







ANR Funding, French DoD funding

AAS

Ref: Tartarin, invited paper IEEE ICNF 2010

PRODF

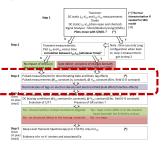


#4 : Failure Analysis in RF Devices –Case of study 2



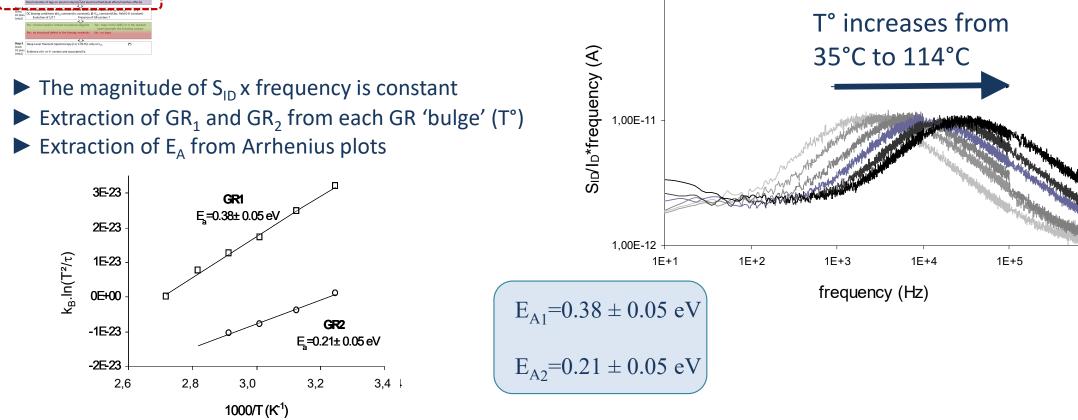
1E+6

CASE STUDY: AIGaN/GaN GH50 & GH25-10 (UMS) under HTRB stresses



noise spectroscopy GR centers evolution vs temperature (saturated zone)

1,00E-10



ANR Funding, French DoD funding

PRODF

AAS

Ref: Int. Conference on Noise and Fluctuation (ICNF) 2011, Toronto, invited paper Ref: Soubercaze IEEE MTTS 2006



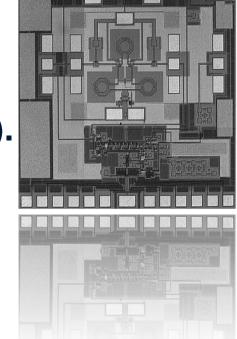




Emerging Technologies / Defect detection & Reliability Analysis

• LFN for non-linear RF circuit design (VCOs, Mixers).

- LFN for Sampling Phase Detectors



- LFN conversion for Low Phase Noise Frequency Synthetizers (VCOs)



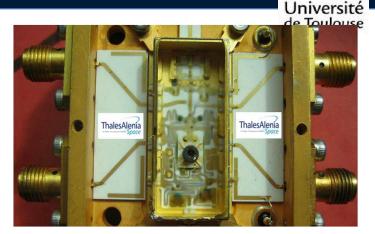




LFN conversion for Sampling Phase Detectors

Low phase noise systems

Heterogen systems, with embedded RF and Optic carriers, and/or digital / analog functions, and/or high number of harmonics or non-linearities and/or new generation/high performances (reliable ?) devices

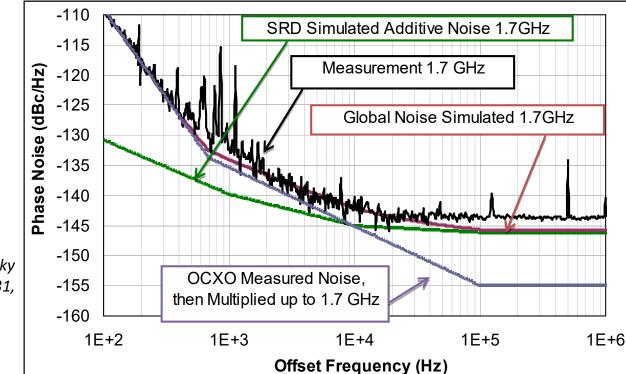


Example : Noise simulation around harmonic 17th of a sampling phase detector

Ref: Cyclostationary shot noise measurements in RF Schottky barrier diode detectors, IEEE Electron Devices Letters, Vol.31, N°1, pp.74-76, Janvier 2010.

Ref: Proc. of the 2009 European Microwave Conf., Rome, oct. 2009, pp. 480-483, J. Graffeuil.

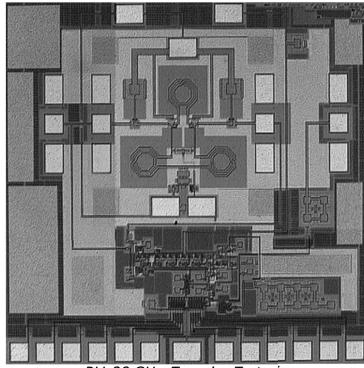


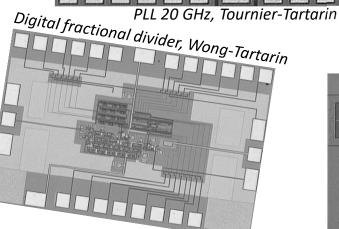




LFN conversion for Low Phase Noise Freq. Synth. (BiCMOS and GaN HEMT VCOs)

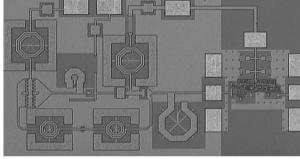


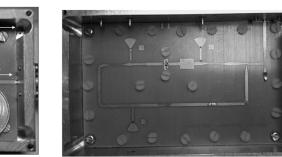




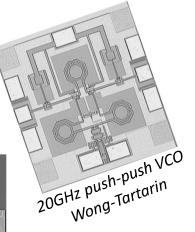
PROG

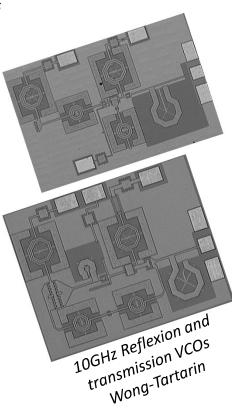
10GHz VCO with divider, Wong-Tartarin





10GHz Hybrid GaN oscillators Soubercaze-Tartarin





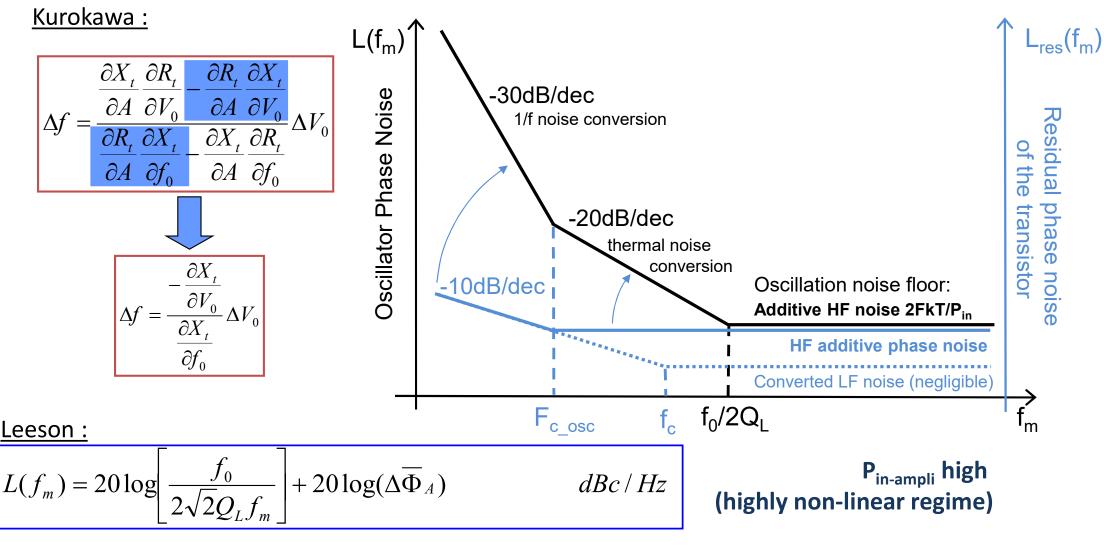


AAS

CNRS



LFN conversion for Low Phase Noise Freq. Synth. (BiCMOS and GaN HEMT VCOs)

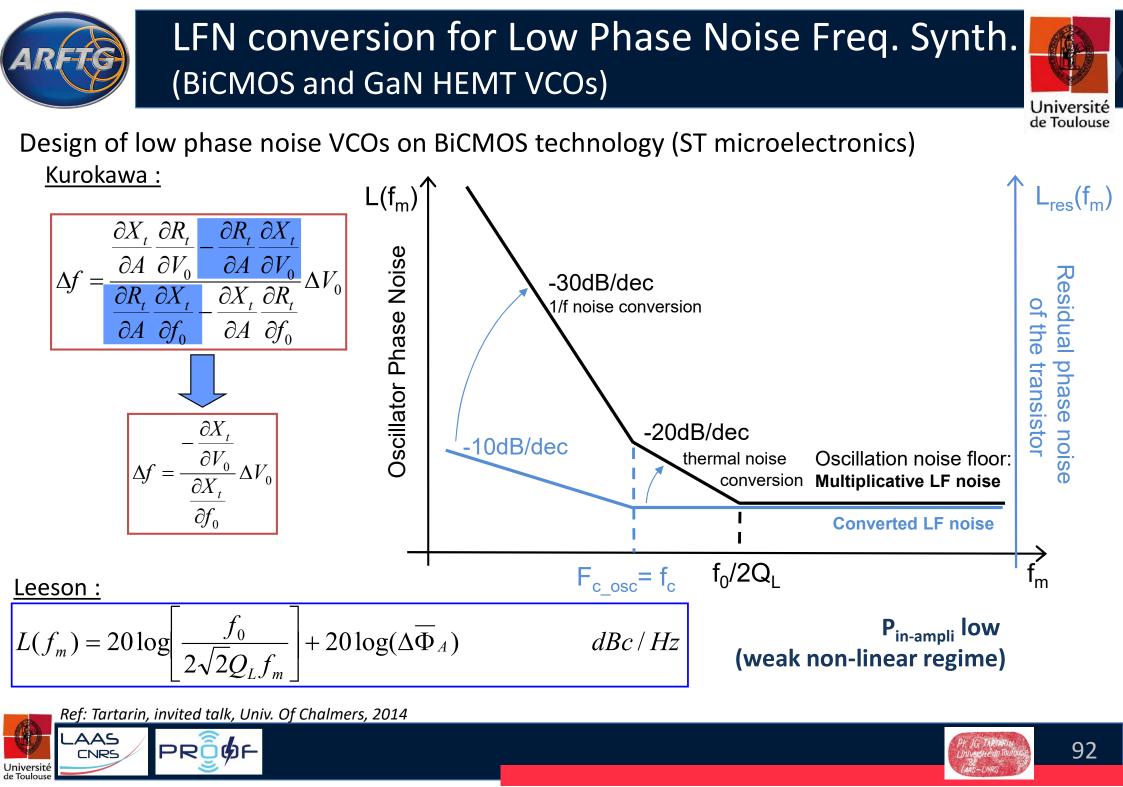


Ref: Tartarin, invited talk, Univ. Of Chalmers, 2014





Université de Toulouse





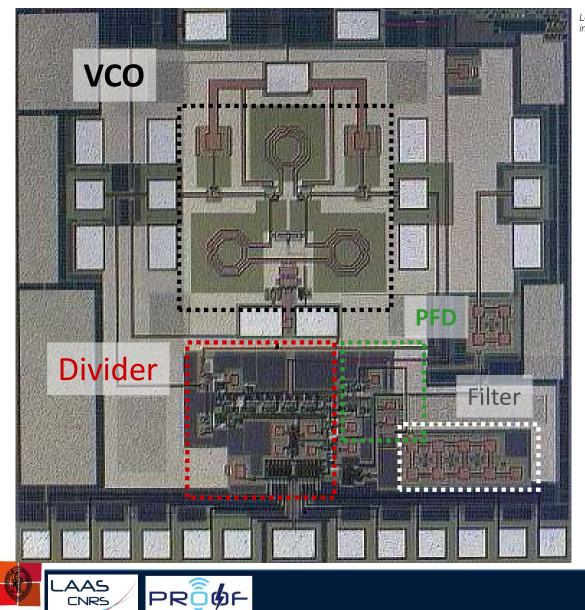
CNRS

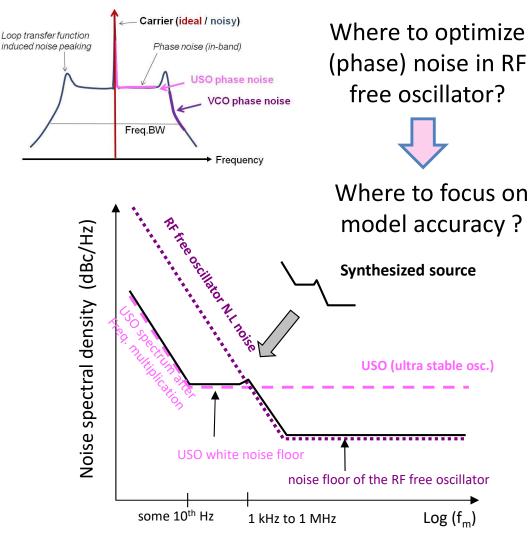
Universite

LFN conversion for Low Phase Noise Freq. Synth. **BiCMOS**

Université de Toulouse

First Fully integrated MMIC PLL @ 20 GHz

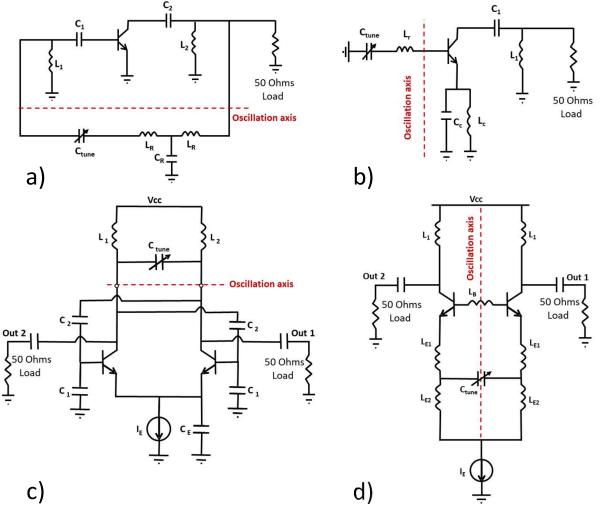




Distance f_m to the carrier (Hz) (SSB)



Design of low phase noise VCOs on BiCMOS technology (ST microelectronics)



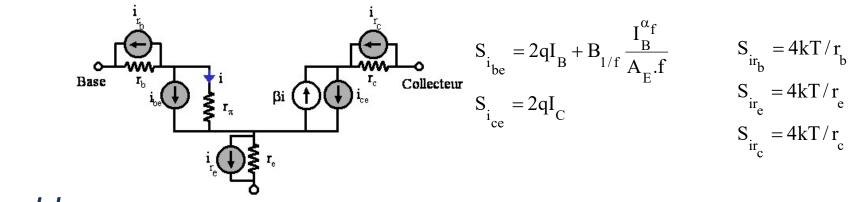
- Device LFN modeling
- Analysis of noise conversion.
- Topology selection prior to design: according to which metrics or FoM?
- Design of the resonator (Q) and of the amplifier (LFN) : reflection or transmission
- Measurement and refinement of the model (if necessary)

Ref: Ph. D. Thesis W. Wong, University of Toulouse, France, 2003





All noise models were developed from our LFN measurement campaigns



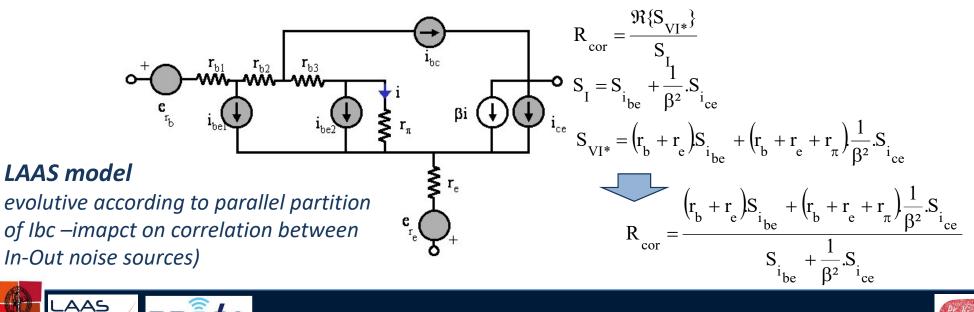


HBTs

Emetteur

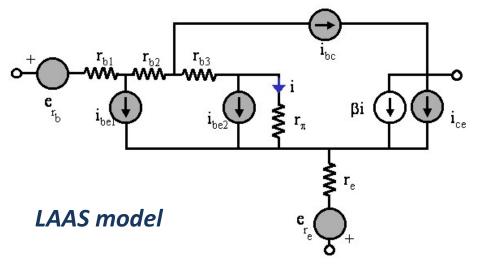
PROØF

SS model with associated LF noise sources





All noise models were developed from our LFN measurement campaigns



Noise partition, according to specific technological developments

PRODE

AAS

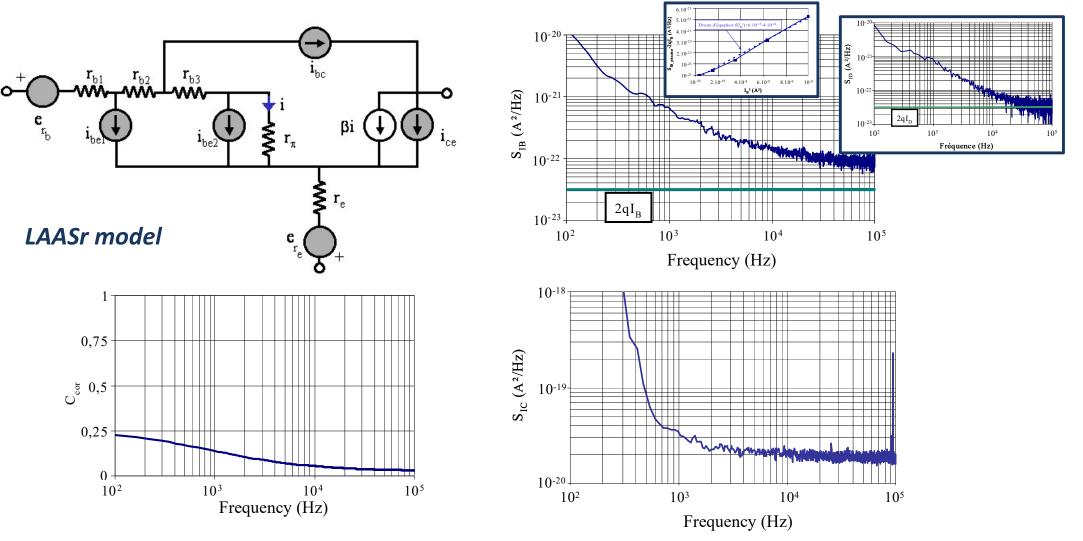
	e _{rb}	e _{re}	i _{be2}	i _{ce}	i bel	i _{bc}
$R_{cor} < (r_e + r_b)$	\forall	\forall	\forall	0	\forall	A
$R_{cor} = (r_e + r_b)$	\forall	\forall	\forall	0	0	0
$R_{cor} > (r_e + r_b)$	\forall	\forall	\forall	\forall	0	0

 $S_{V} = (S_{rb} + S_{rc}) + (r_{b1} + r_{c})^2 . S_{ibc1} + (r_{b} + r_{c})^2 . S_{ibc2}$ $+\left(r_{b}+r_{e}+r_{\Pi}\right)^{2}\cdot\frac{S_{ice}}{\beta^{2}}+\left(\frac{Z_{entrée}}{\beta}+r_{b1}+r_{b2}\right)^{2}S_{ibc}$ $S_{I} = S_{ibe1} + S_{ibe2} + \left(1 + \frac{1}{R}\right)^{2} S_{ibc} + \frac{S_{ice}}{R^{2}}$ $S_{IV*} = (r_{b1} + r_{e})S_{ibe1} + (r_{b} + r_{e})S_{ibe2} + (r_{b} + r_{e} + r_{\Pi})\frac{S_{ice}}{R^{2}}$ $+\left(\frac{Z_{\text{entrée}}}{\beta} + r_{\text{b1}} + r_{\text{b2}}\right)S_{\text{ibc}}$ $R_{cor} = \frac{(r_{b1} + r_{e})S_{ibel} + (r_{b} + r_{e})S_{ibe2} + (r_{b} + r_{e} + r_{\Pi})\frac{S_{ice}}{\beta^{2}} + (\frac{Z_{entrée}}{\beta} + r_{b1} + r_{b2})S_{ibc}}{S_{ibel} + S_{ibe2} + (1 + \frac{1}{\beta})^{2}S_{ibe} + \frac{S_{ice}}{\beta^{2}}}$



Université de Toulouse

All noise models were developed from our LFN measurement campaigns

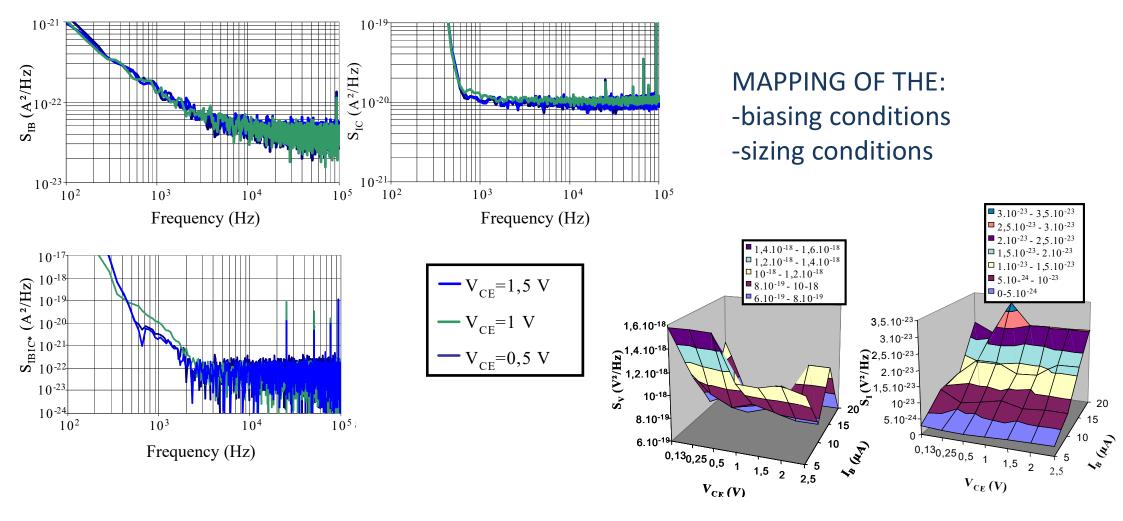


Ref: Ph. D. Thesis L. Bary, University of Toulouse, France, 2001





All noise models were developed from our LFN measurement campaigns



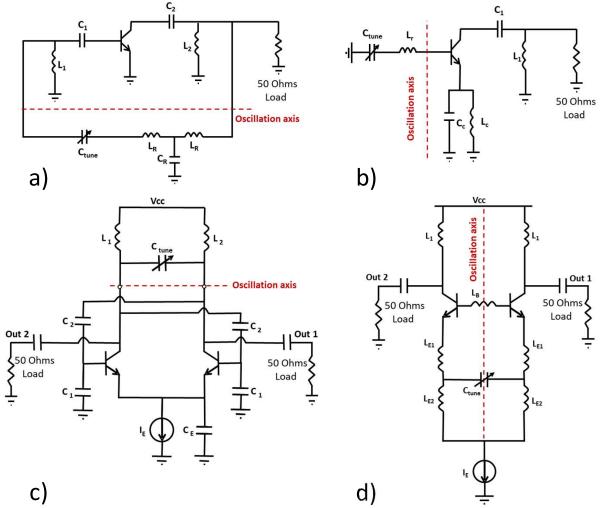
Ref: Ph. D. Thesis L. Bary, University of Toulouse, France, 2001







Design of low phase noise VCOs on BiCMOS technology (ST microelectronics)



Device LFN modeling



- Analysis of noise conversion.
- **Topology selection prior to design:** according to which metrics or FoM?
- Design of the resonator (Q) and of the amplifier (LFN) : reflection or transmission
- Measurement and refinement of the model (if necessary)

$$L(f_m) = 10x \log\left(\left(\frac{f_0}{f_m}\right)^2 \left(\frac{R_L}{Q_L^2} \frac{FkT}{V_0^2}\right)\right)$$

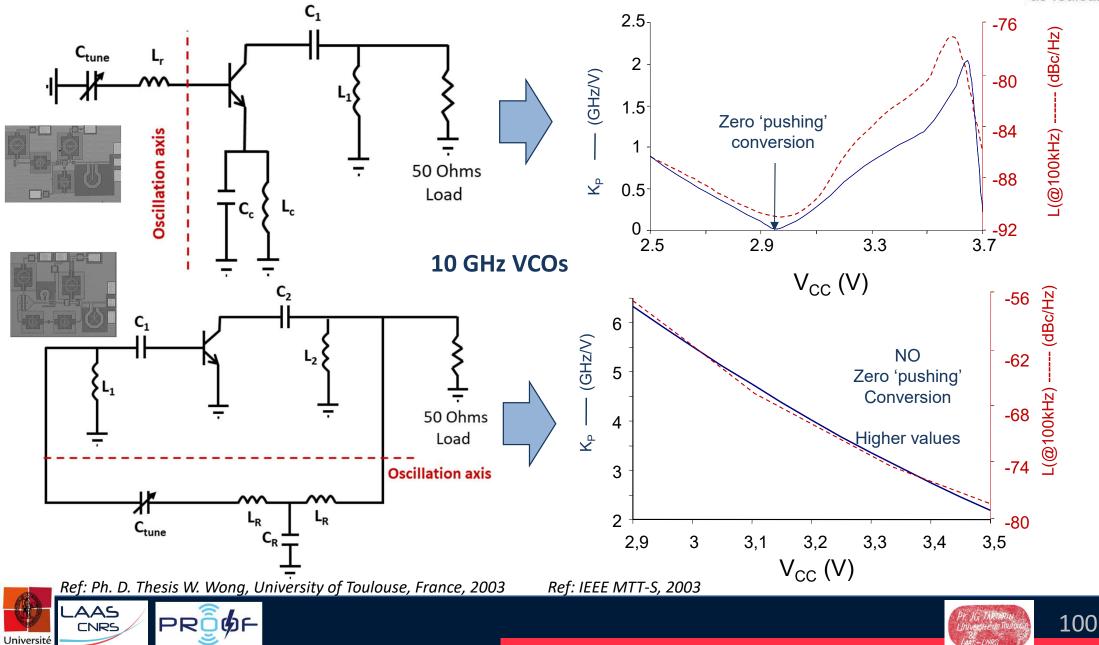
Ref: Tartarin et al. Journal of MDPI, 2022, Evolution Trends and Paradigms of Low Noise Frequency Synthesis and Signal Conversion Using Silicon Technologies Ref: Ph. D. Thesis W. Wong, University of Toulouse, France, 2003



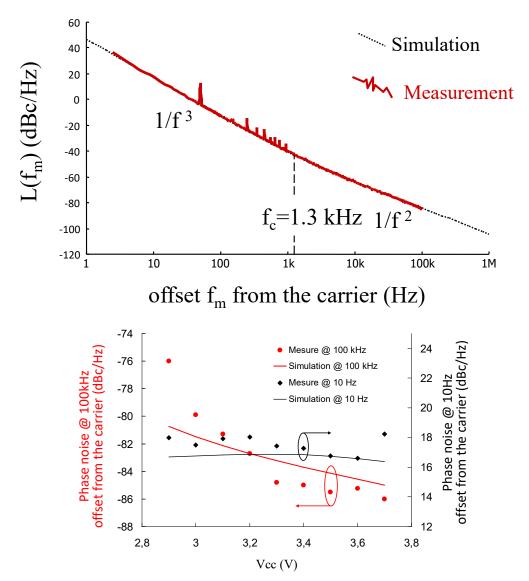












$$Si_{be} = K \frac{Ibe_{DC}^{\alpha}}{f^{\beta}} + 2 q Ibe_{DC}$$

Phase noise computed with ADS software (Keysight, prev. Agilent)

At the time, pnfm did not account for the noise floor far from the carrier → pnmx was also considered (matrix conversion, account for the noise floor)

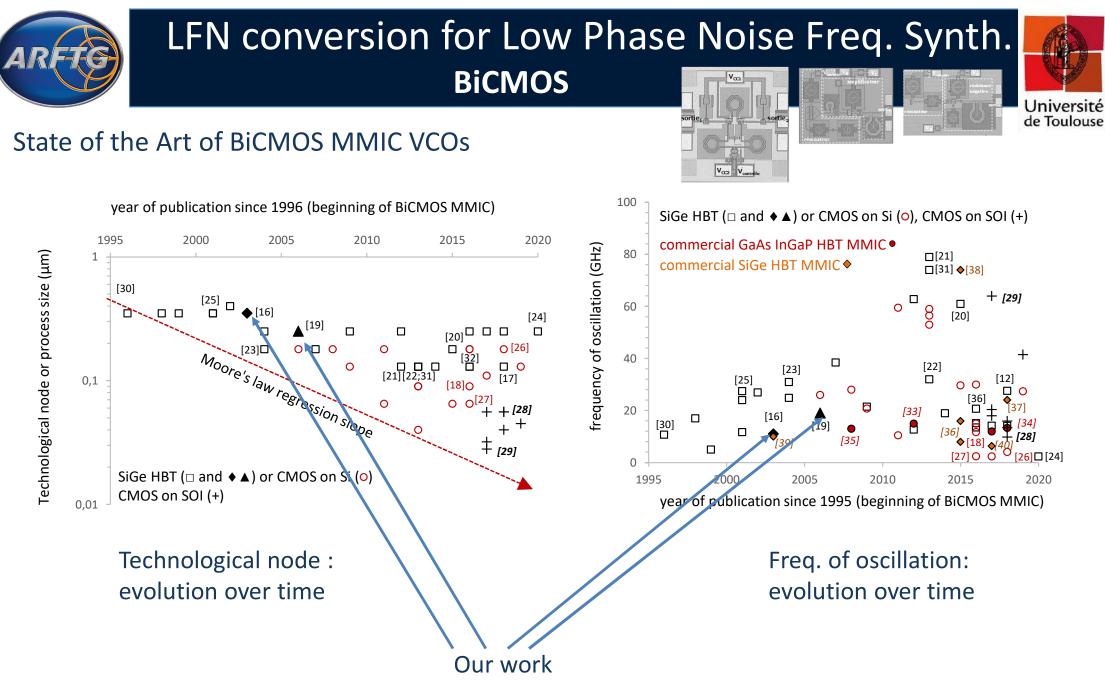
Less than 2dB error @10Hz Less than 4.5dB error @100kHz

Ref: Ph. D. Thesis W. Wong, University of Toulouse, France, 2003 Ref: IEEE MTT-S, 2003





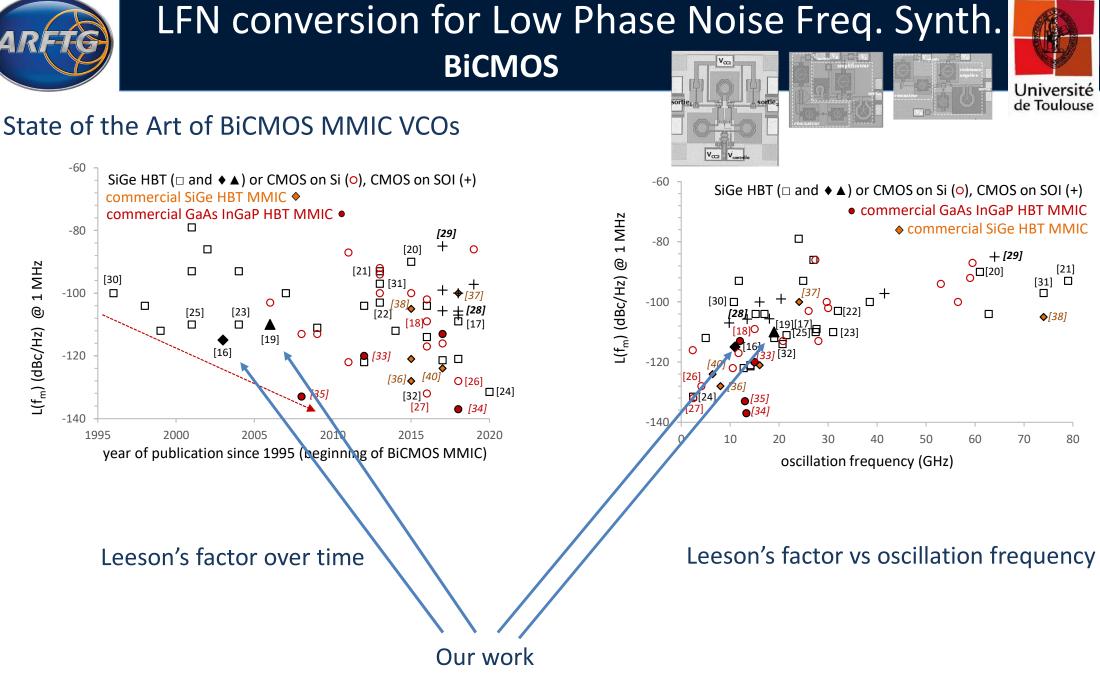
Université de Toulouse



Ref: Tartarin et al. Journal of MDPI, 2022, Evolution Trends and Paradigms of Low Noise Frequency Synthesis and Signal Conversion Using Silicon Technologies







Ref: Tartarin et al. Journal of MDPI, 2022, Evolution Trends and Paradigms of Low Noise Frequency Synthesis and Signal Conversion Using Silicon Technologies







State of the Art of BiCMOS MMIC VCOs :

HOW TO DEFINE IT ? \rightarrow Figure of Merit

ACCORDING TO WHICH METRICS ? \rightarrow real use conditions AND easy to figure it out

$$L(f_m) = 10x \log\left(\left(\frac{f_0}{f_m}\right)^2 \left(\frac{R_L}{Q_L^2} \frac{FkT}{V_0^2}\right)\right)$$

Leeson: the fundamental !

 $FOM = L(f_m) - 10x log\left(\left(\frac{f_0}{f_m}\right)^2 \frac{1}{P_{DC}}\right) = -10x log\left(\left(\frac{R_L}{Q_L^2} \frac{FkT}{V_0^2}\right) x P_{DC}\right) Adding P_{DC}.$ Not enough realistic (lower P_{DC} will lead to low output power, need of **buffer amplifier** \rightarrow residual phase noise) $FOM_{PRF} = L(f_m) - 10x log\left(\left(\frac{f_o}{f_m}\right)^2 \frac{P_{out}}{P_{DC}}\right)$ Adding P_{RF} . Not enough realistic (does not account for controlled oscillator \Rightarrow Q factor largely impacts Leeson formula !

$$FOM_{PRF\&T} = L(f_m) - 10x log\left(\left(\frac{f_0}{f_m}\right)^2 \left(\frac{TR\%}{10}\right)^2 \frac{P_{out}}{P_{DC}}\right) \text{ Adding } \Delta \text{tune \& P_{RF}}.$$

It seems quite realistic and not too elaborate

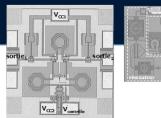
Ref: Tartarin et al. Journal of MDPI, 2022, Evolution Trends and Paradigms of Low Noise Frequency Synthesis and Signal Conversion Using Silicon Technologies Ref: Ph. D. Thesis W. Wong, University of Toulouse, France, 2003





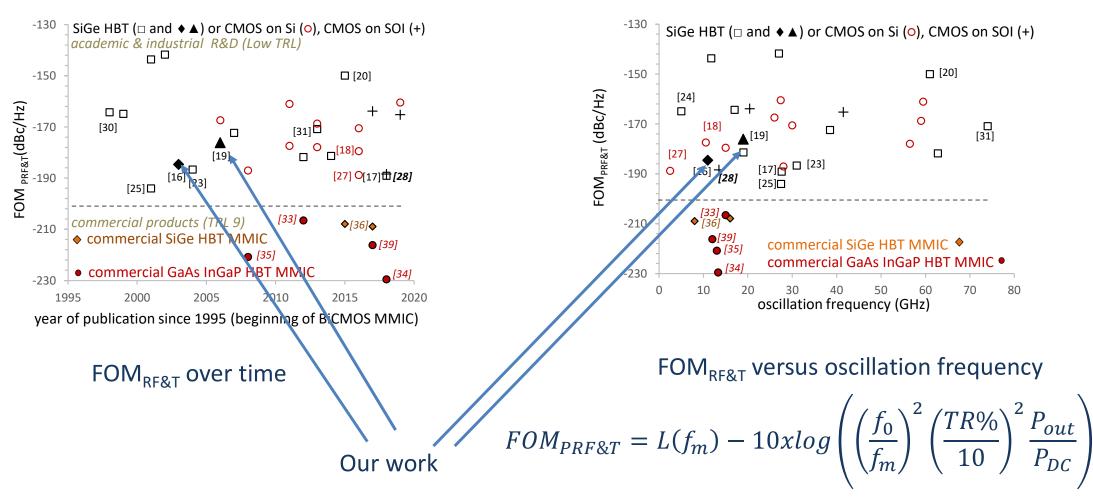


BiCMOS





State of the Art of BiCMOS MMIC VCOs Proposed FOM with tuning range and RF output power



Ref: Tartarin et al. Journal of MDPI, 2022, Evolution Trends and Paradigms of Low Noise Frequency Synthesis and Signal Conversion Using Silicon Technologies

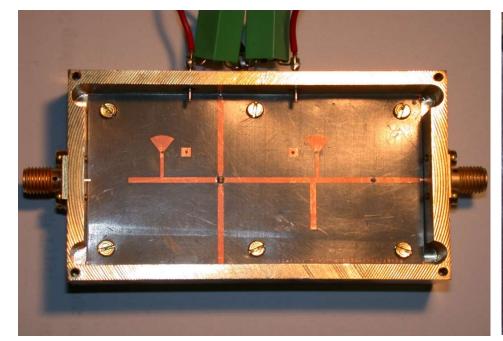


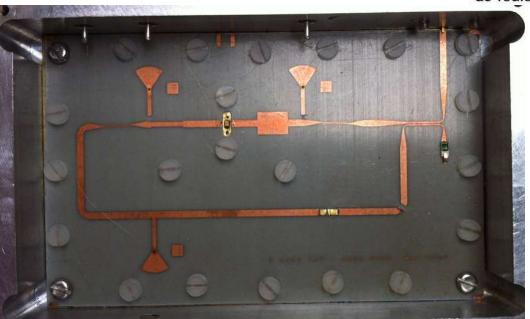




LFN conversion for Low Phase Noise Freq. Synth. GaN HEMT (VC)Os







Fixed Oscillator (10 GHz) (Soubercaze 2006)

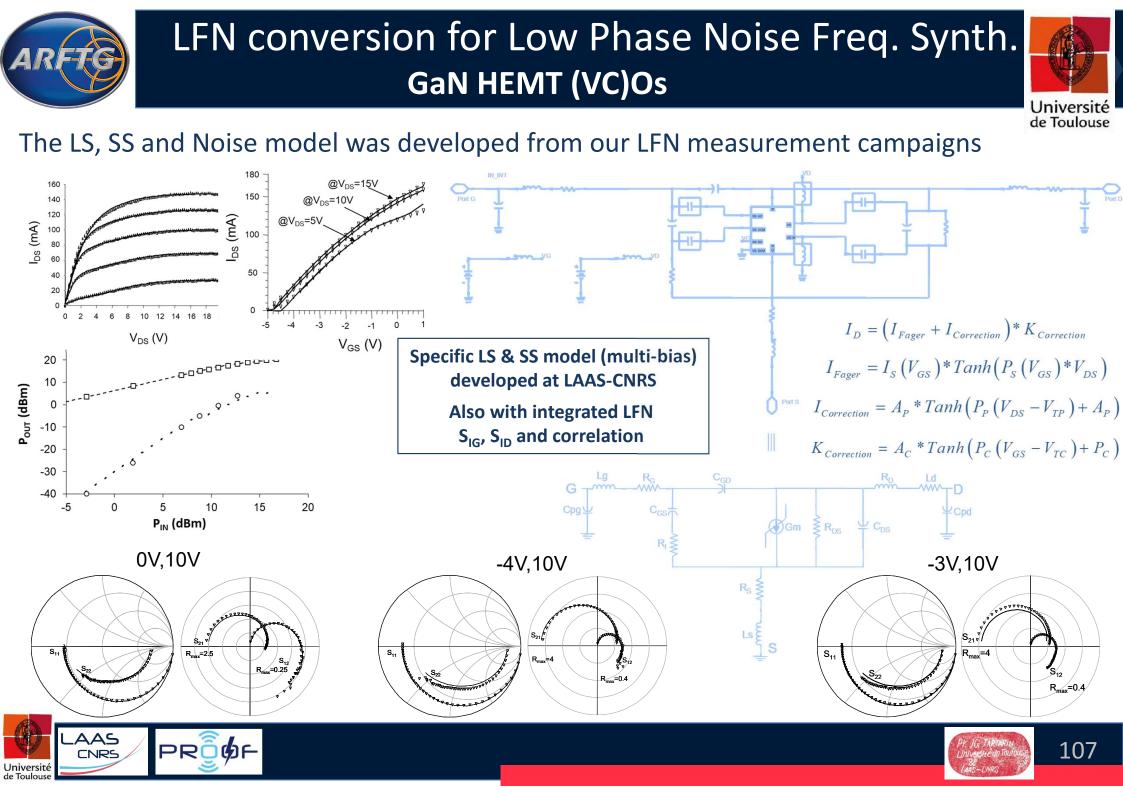
P_{out}=20dBm L(100kHz)= -115dBc/Hz Voltage Controlled Oscillator (9.2 GHz) (Tartarin 2008)

P_{out}=23dBm L(100kHz)= -92dBc/Hz 2.5% tuning around f₀

Based on the same GaN HEMT chip:2x75µm gate width devices from Thales - TRT



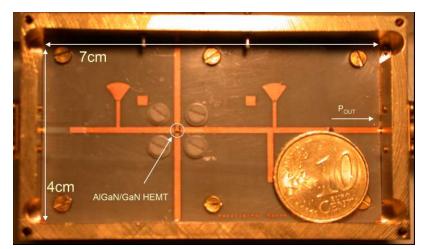


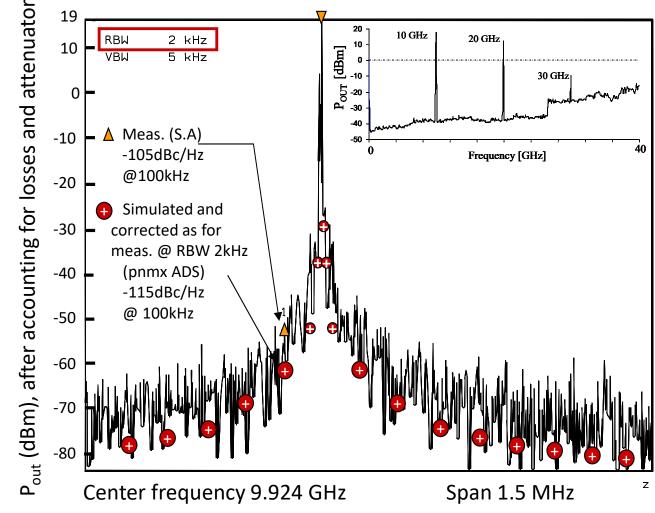


LFN conversion for Low Phase Noise Freq. Synth. GaN HEMT (VC)Os



→ High output power(19 dBm), no buffer amplifier (Radar)



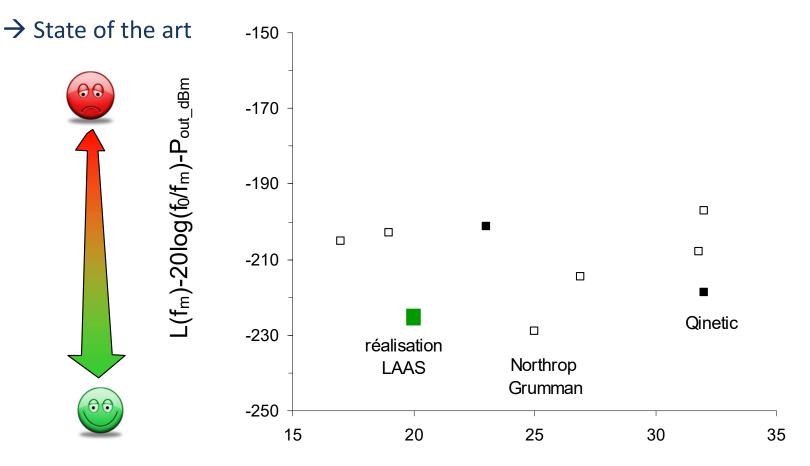








GaN oscillators @ 10 GHz (till 2016)



Output power (dBm)

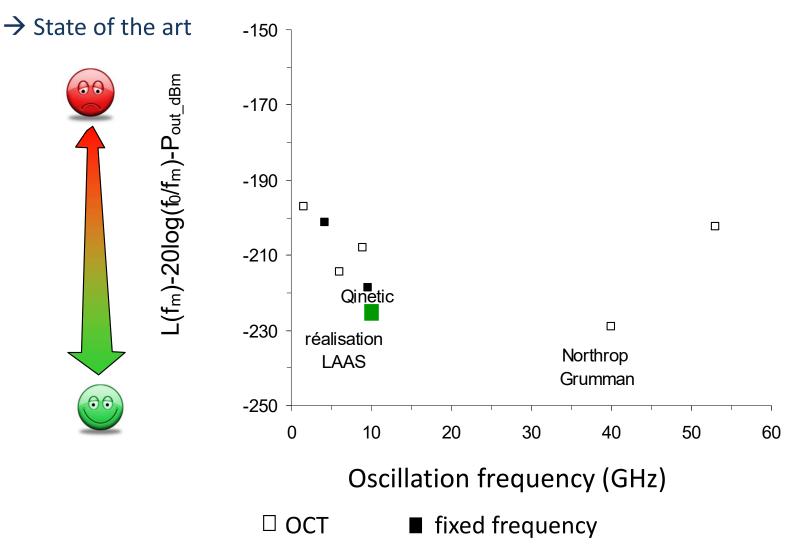
fixed frequency





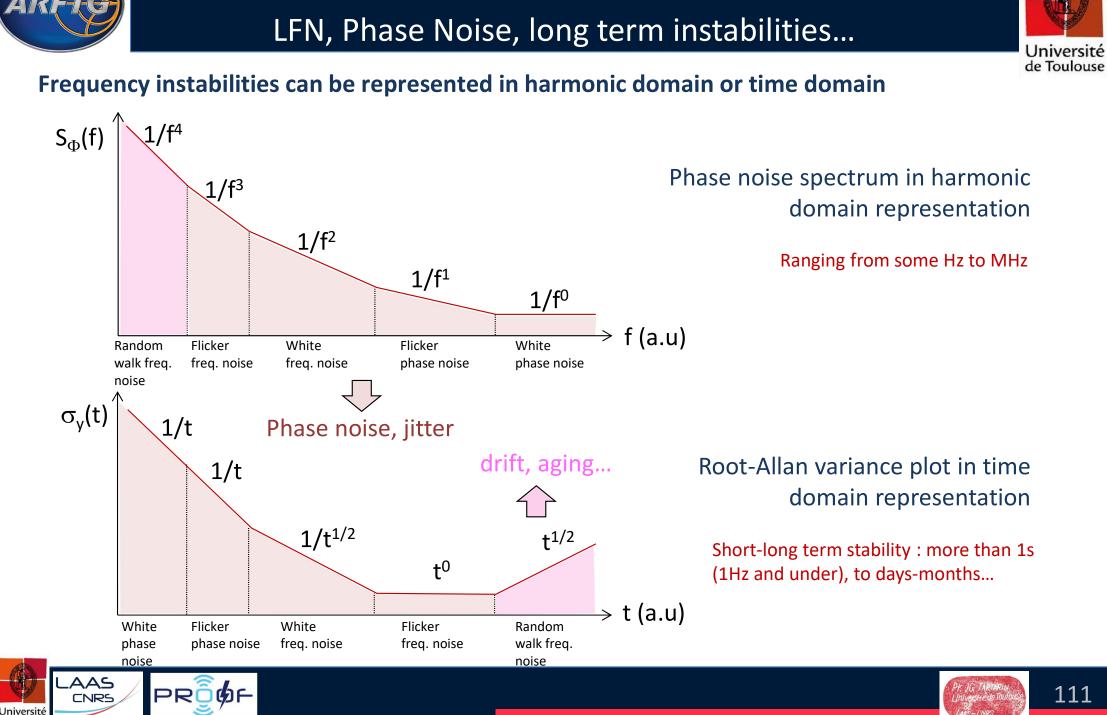


GaN oscillators @ 10 GHz (till 2016)









CONCLUSIONS & PERSPECTIVES



CONCLUSIONS & PERSPECTIVES Lets ask Chap GPT !



This was my first question for Chat GPT !!!



Q1 JGT : How has low-frequency noise metrology been an accelerator in microelectronics research?

Low-frequency noise metrology has played a crucial role in microelectronics

research by providing insights in the behavior of electronic devices at a fundamental level. It has helped respectively independent of the origin and mechanisms of low-frequency noise in semicon of the ces, leading to improvements in device performance, reliability, and complete characterizing and quantifying low-frequency noise, researchers have of the approximation of identify and address issues related to device and material defects, ultimately driving advancements miniaturization, proces in microelectropy teopilitogy. Additionally, low-frequency noise metrology has contributed to the deligopment of new materials, device structures, and fabrication techniques, further celerating progress in microelectronics research. For more in-depth information on this topic, I recommend consulting specialized sources or experts in the field.







CONCLUSIONS & PERSPECTIVES Lets ask Chap GPT !



This was my second question for Chat GPT !!!



Q2 JGT : Tell me about Low Frequency electronic noise, for what use in applied research in the decades to come?

Low-frequency electronic noise has many potential applications in applied research for the coming decades. It is used in fields such as **spectroscopy**, **wireless communication**, **weak signal detection**, **environmental monitoring** and **fundamental physics research**. Additionally, it could be leveraged for emerging applications such as quantum **technology**, **biotechnology** and quantum communications. However, for more detailed information on this topic, I recommend consulting specialized sources or experts in the field.

For sure, if Chat GPT exists, and when it evolves in the future – it will be partly thanks to LFN studies on quantum electronics.







LFN still in the race from low to high TRL contexts

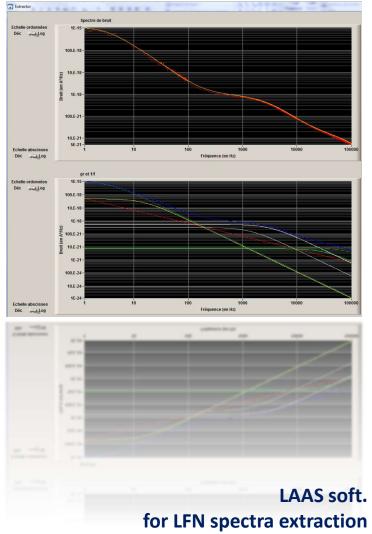
(2/3-5)

- Case of study
- Physics and Theory
- Technology exploration

- (6-8) - Industry quality
- Device selection

Time for questions









Reliability studies; example of an academic methodology and tools for non destructive defect analysis

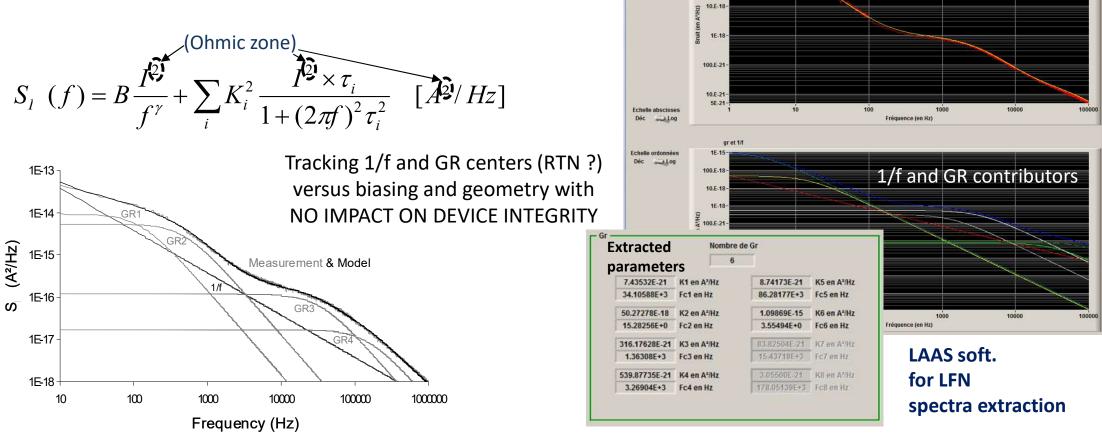
100.E-1



+ mode

Low Freq. Noise spectroscopy for the detection and tracking of defects – degradation mechanisms

-SiGe HBT technologies Stmicro / IBM / SiGeMicrosystems -GaN HEMT UMS GH50-GH25, TRT III-V Lab, IEMN, Ommic



LAAS : labelled by KEYSIGHT as European platform for LF Noise and RT Noise measurement



